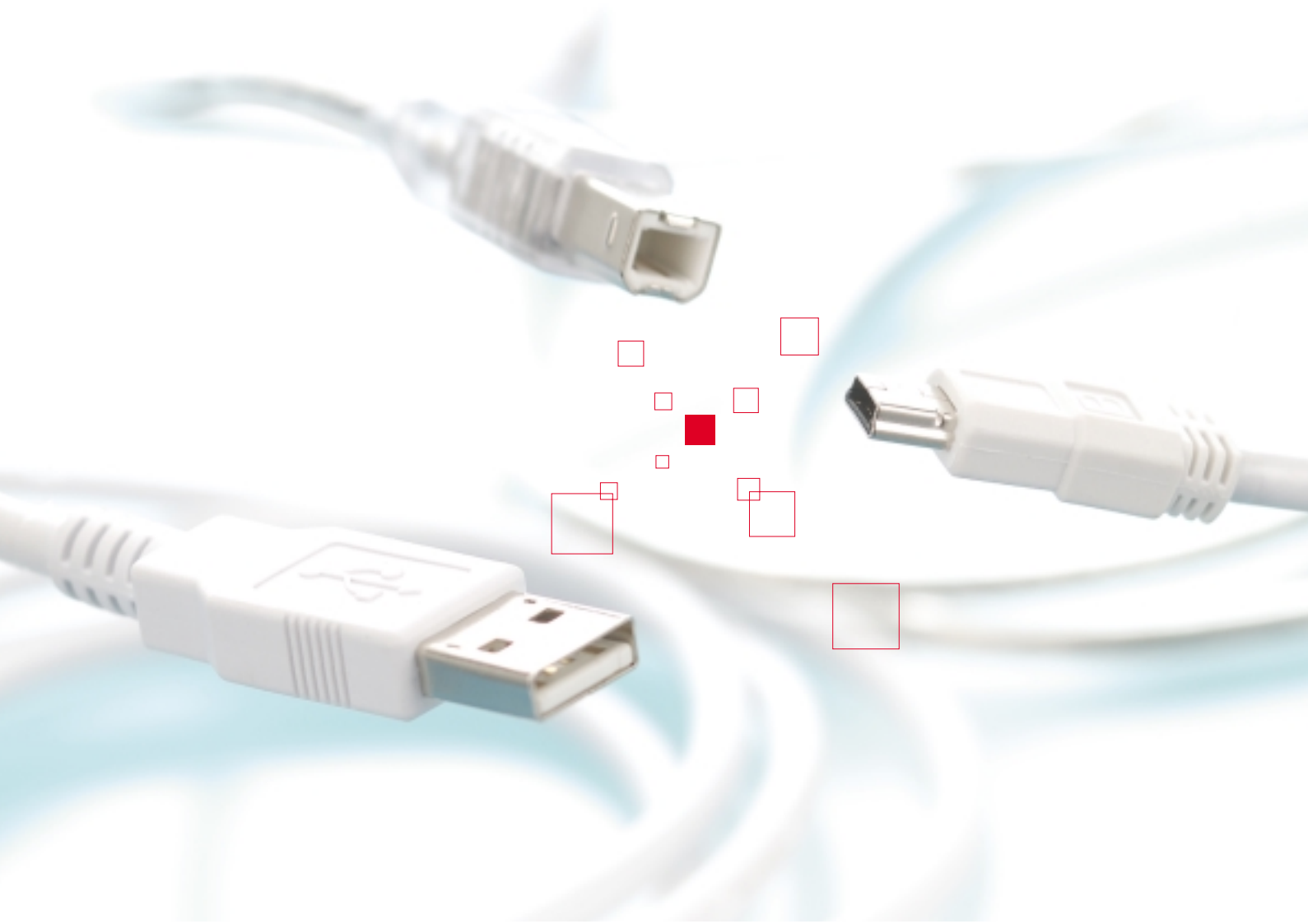


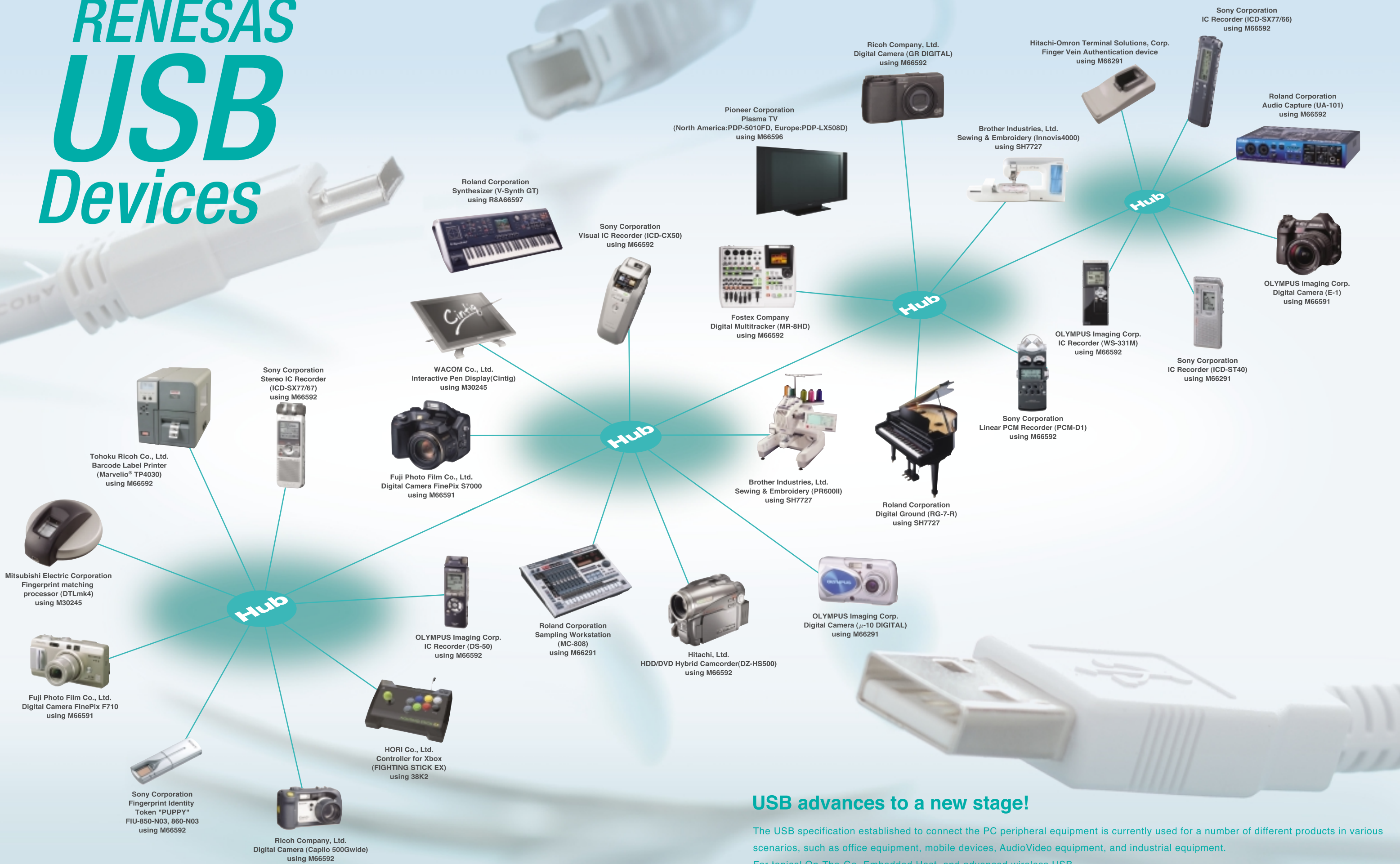
2007.10

Everywhere you imagine. **RENESAS**

Renesas USB Device



RENESAS USB Devices



USB advances to a new stage!

The USB specification established to connect the PC peripheral equipment is currently used for a number of different products in various scenarios, such as office equipment, mobile devices, AudioVideo equipment, and industrial equipment. For topical On-The-Go, Embedded Host, and advanced wireless USB—Renesas continues to provide you with the ideal USB devices to meet customer needs.

Various USB device expansions and superior development environments strongly supports customer's product development.

Full product lineup

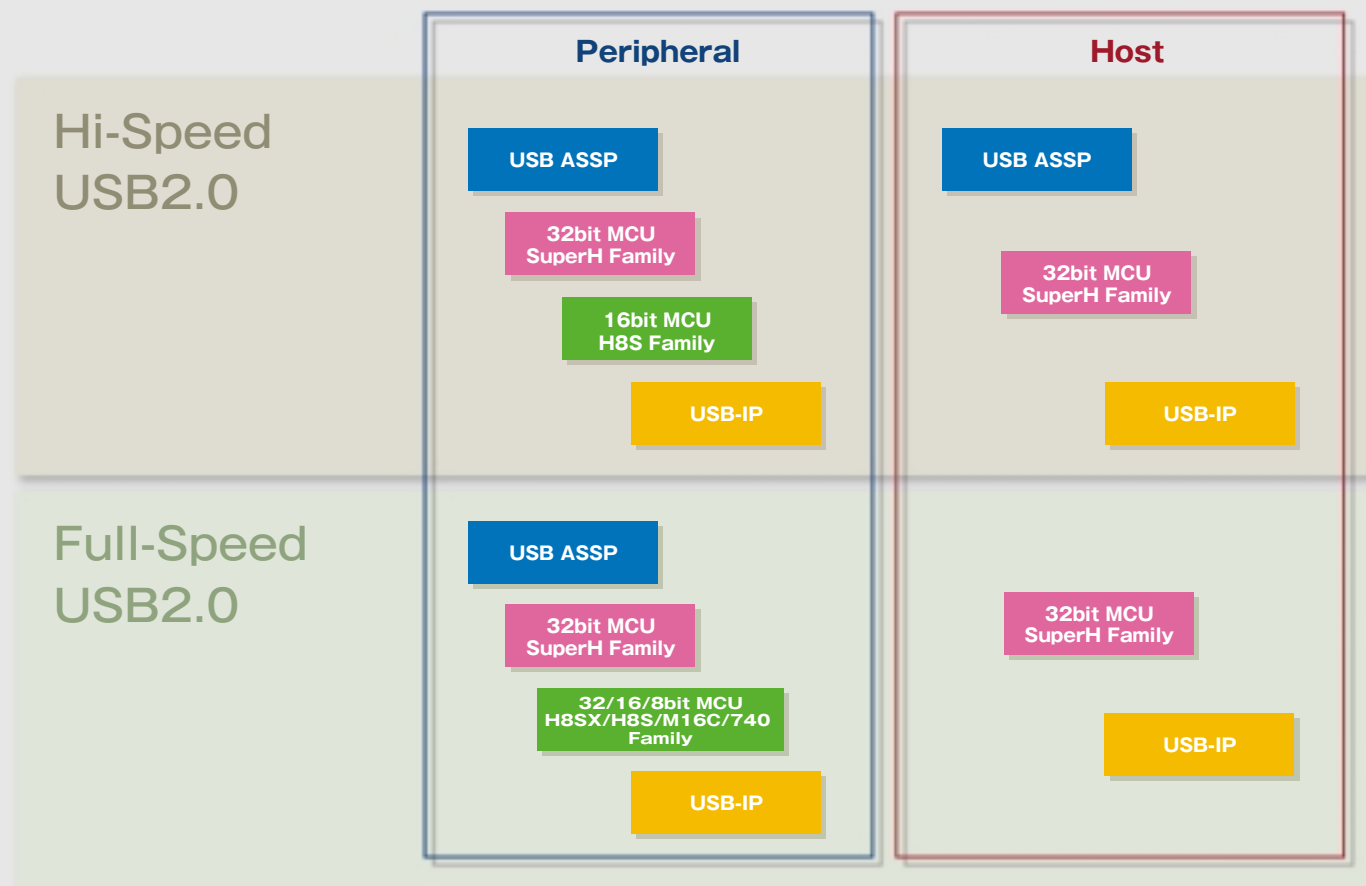
Renesas USB product lineup has expanded to wireless USB devices in addition to USB microcomputers and USB ASSPs.

System proposition

Renesas USB also creates an original IP library and we can offer suitable system to our customers.

Development support

We prepare F/W for all devices. In addition, with strong alliances among various partner vendors, we can provide excellent support for customers during development of their USB systems.



The Renesas USB can play an important role in many scenarios.

Office

Entertainment

Mobile

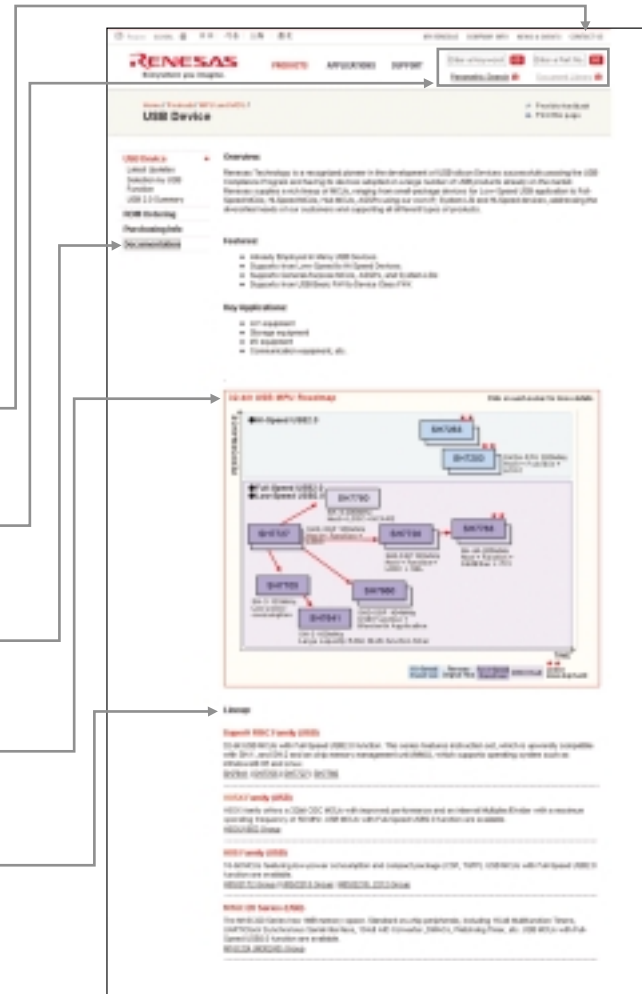
Various Renesas USB device

Renesas USB device Website

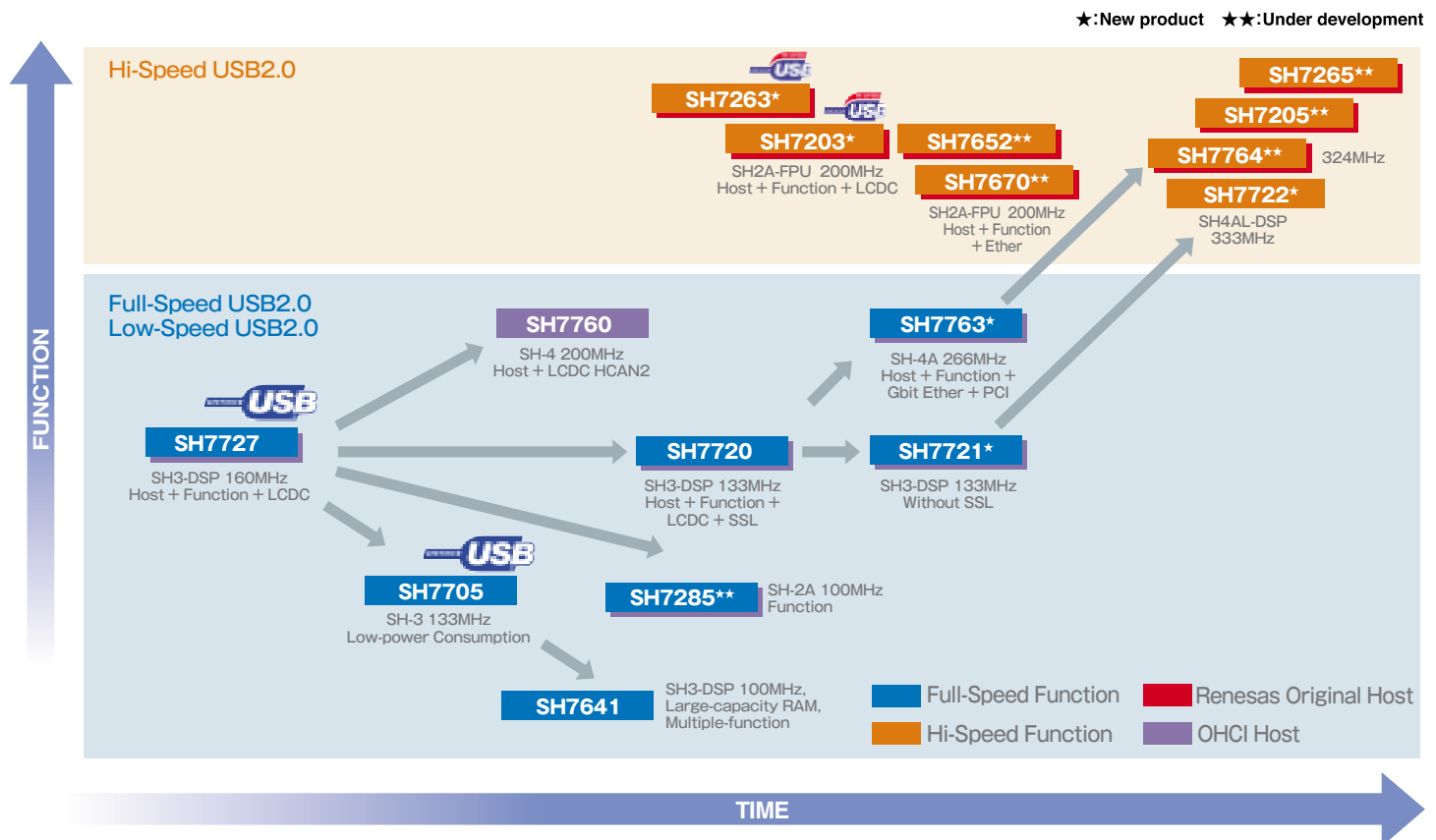
<http://www.renesas.com/en/usb>

Renesas USB device Website provides you with the latest technical information, which is useful to customers in selecting the right Renesas USB device or developing their system in a time-efficient manner.

Contact	Please use this contact information for technical inquiries, etc.
Various searches	Please use the various search functions.
Document download	The hardware manual, the software manual, etc., are available for download.
Product expansion	Information regarding each device can be accessed from the expansion plan, too.
Lineup	Relevant documents, such as application notes, etc., in addition to the product specifications of each device, are also available for downloading.

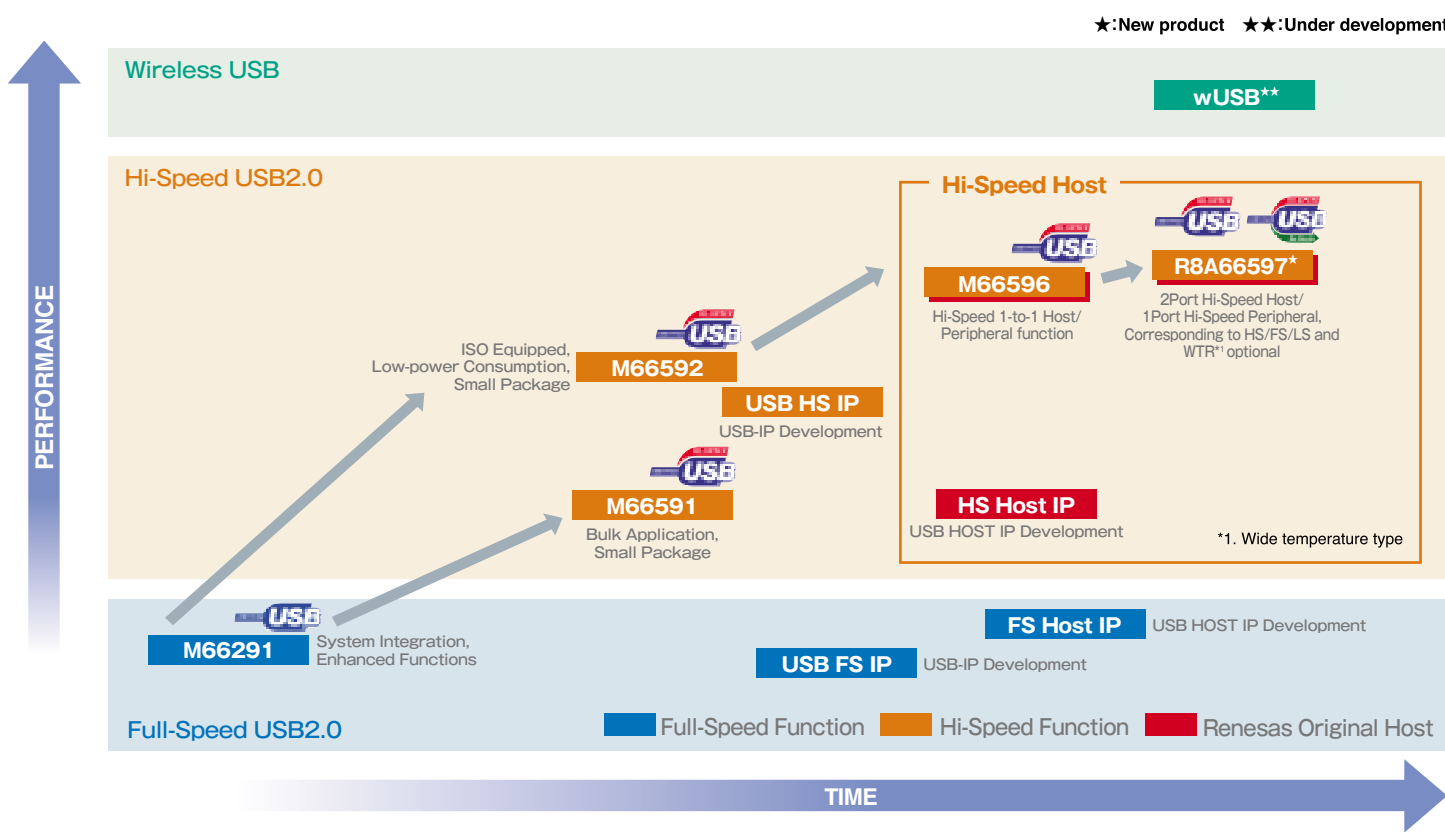


USB MPU Road Map SuperH™ Family

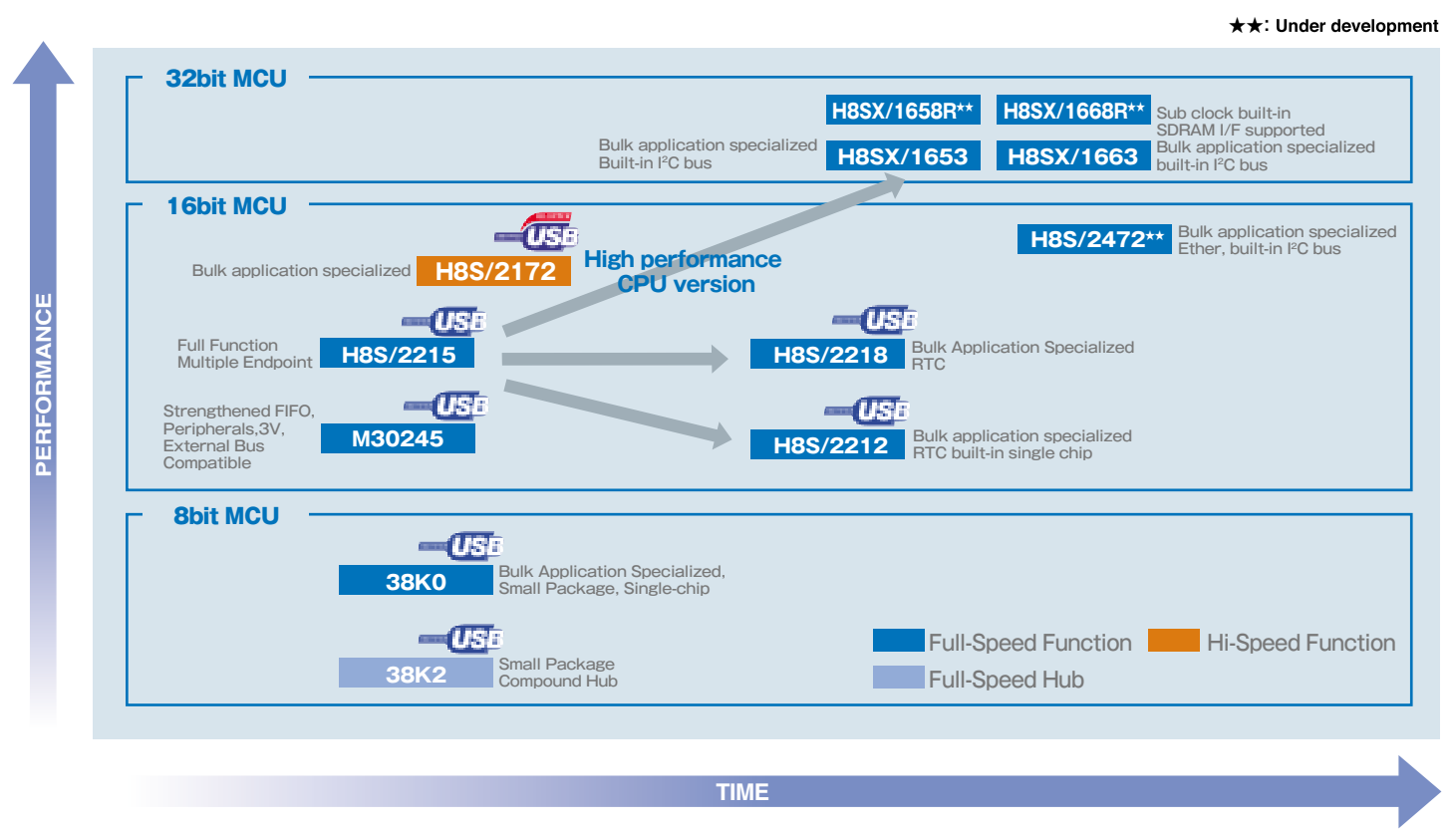


*1: SuperH™ is a trademark of Renesas Technology Corp.

USB ASSP Road Map



USB MCU Road Map (M16C, H8SX, H8S, 740 Family)



Selection Map

USB ASSP

	Package	Operation Voltage (V)	Operating Temperature (°C)	DMA interface	Other Functions		USB Function						Application			
					PLL	spec	Speed	Transfer type	Endpoints	Data Buffer	Other Functions					
R8A66597*	80-pin LQFP 81-pin LFBGA	Power Source 3.0 to 3.6, I/O 1.6 to 2.0/ 2.7 to 3.6	-20 to 85 -40 to 85 ¹	2ch	Frequency multiplying circuit	16-bit CPU bus interface (For address/data bus, there are separate type and multiplex type options)	USB2.0	Host or Function ^{*2} Hi-Speed/ Full-Speed/ Low-Speed (Host only)	Control, Interrupt, Bulk, Isochronous	10pipes (Endpoints)	Built-in FIFO (Total 8.5K bytes) ^{*3} (Max 2048 bytes) ^{*4}	Built in USB Pull-down Resistor (In Host Mode), Built in USB Pull-up Resistor (In Peripheral Mode)	USB Output Resistor (In Full-Speed) Built in USB Termination Resistor (In Hi-Speed)	Vbus Detector	DVD recorder, Mobile information terminal, Set top box, Audio equipment, DSC, DVC Printer, Storage equipment	
M66596	64-pin LQFP 64-pin FBGA 64-pin VFBGA	Power Source 1 : 1.35 to 1.65, Power Source 2 : 3.0 to 3.6, I/O 1.6 to 2.0/ 2.7 to 3.6	-20 to 85					Host or Function ^{*2} Hi-Speed/ Full-Speed								8pipes (Endpoints)
M66592				1ch				Hi-Speed/ Full-Speed	Control, Interrupt, Bulk	7pipes (Endpoints)	Built-in FIFO (Total 3.5KByte) ^{*3} (Max 512Byte) ^{*4}	USB Pull-up Power Output Pin Power Management Output Pin			Musical instrument, Printer, Scanner, Modem, Portable phone, DVC, DSC, other PC peripheral devices	
M66591	80-pin LQFP	Power Source 3.3 to 3.6, I/O 1.7 to 2.0/ 2.7 to 3.6	-20 to 85					Full-Speed								Control, Interrupt, Bulk, Isochronous
M66291	48-pin LQFP 52-pin VQFN	Power Source 3.3 to 3.6, I/O 2.7 to 3.6/ 4.5 to 5.5	-20 to 85	2ch		8/16-bit CPU bus interface										

*1: Wide temperature type *2: Exclusive use for Host and Function *3: Total number of built-in FIFO *4: Maximum number of bytes allowing transmissions to and from just one endpoint. Using the double buffer mode doubles transmission capability.

USB MCUs

	Group	Package	Operation Voltage (V)	Operating Temperature (°C)	DMA interface	Other Functions		USB Function						Application										
						I/O Ports	spec	Speed	Transfer type	Endpoints	Data Buffer	Other Functions												
32bit	SH7722*	449-pin BGA	1.15 to 1.3V(266MHz), 1.25 to 1.35V(333MHz)/ 3.0 to 3.6V(I/O)	-20 to 70/ -40 to 85	USB function DMAC x 6ch	149	H.264/MPEG4 codec JPEG codec LCDC, NAND Flash I/F camera I/F, IIC, SCIF	USB2.0	Hi-Speed Function	Control, Interrupt, Bulk, Isochronous	8Endpoints	FIFO 4KByte Double buffer	With USB Pull-up Control Terminal	Vbus Detector	One-segment navigation Portable navigation Portable multimedia, player Camera applicable equipment									
	SH7203* SH7263*	240-pin QFP	1.1 to 1.3/ 3.0 to 3.6(I/O)	-20 to 85/ -40 to 85	USB function DMACx8ch	99	LCDC NAND Flash Interface I ² C Bus, CAN	Hi-Speed Host or Function ^{*5}	FIFO 8KByte Double buffer Host-shared memory: SRAM, SDRAM															
	SH7763*	449-pin BGA	1.1 to 1.3/ 3.0 to 3.6(I/O) 2.3 to 2.7(DDR)	-20 to 75	USB Host DMACx6ch	107	Giga Ethernet Controller PCI Bus Controller LCDC, Security Accelerator, MMCI, I ² C Bus	Full-Speed Function & OHCI Host	FIFO 544Byte Double buffer Host-shared memory: XY RAM space															
	SH7705	208-pin LQFP 208-pin CSP	1.4 to 1.6/ 3.0 to 3.6(I/O)	-20 to 75	DMACx4ch	105	RTC, IrDA	Full-Speed	FIFO 288Byte Double buffer							USB pull-up control is a general purpose I/O								
	SH7727	240-pin HQFP 240-pin CSP	1.75 to 2.05/ 3.6(I/O)(160MHz)		USB Host DMACx4ch	104	DSP, LCDC, Built-in RTC	Full-Speed Function & OHCI Host	FIFO 288Byte Double buffer Host-shared memory: SDRAM space															
	SH7641	256-pin LFBGA	1.7 to 1.9/ 3.0 to 3.6(I/O)	-40 to 75	DMACx4ch WDT,INTC	164	I ² C Bus	Full-Speed	FIFO 288Byte Double buffer							With USB Pull-up Control Terminal								
	SH7720 SH7721*	256-pin CSP(17mm□) 256-pin CSP(11mm□)	1.4 to 1.6/ 3.0 to 3.6(I/O)	-20 to 75	USB Host DMACx6ch	117	DSP, LCDC, SSL Accelerator (SH7720) MMCI, RTC, IrDA, I ² C Bus	Full-Speed Function & OHCI Host	FIFO 544Byte Double buffer Host-shared memory: SRAM, SDRAM, XY RAMspace							-	-	Network Equipment IT Terminal Digital Appliance						
	SH7760	256-pin BGA	-20 to 75/ -40 to 85	USB Host DMACx8ch	70(MAX)	LCDC, I ² C Bus Audio interface	OHCI Host	Host:127Endpoints Function:6Endpoints	Host-shared memory: Internal RAM 8Kbyte															
	H8SX/1668R**	144-pin LQFP	-20 to 75 (-40 to 85) ^{*1}	EXDMAx4ch DMACx4ch DTC	101	I ² Cx2ch Bus Interface, PPG SDRAM I/F, Sub-clock circuit E10A compliant	USB2.0	Full-Speed	FIFO Total 288Byte Max 64Byte							With USB Pull-up Control Terminal	Vbus Detector	4Endpoints	-	-	POS Scanner			
	H8SX/1658R**	120-pin LQFP																				EXDMAx2ch DMAx4ch DTC	84	I ² Cx2ch Bus Interface, PPG E10A compliant
	H8SX/1663	144-pin LQFP																				DMACx4ch DTC	101	I ² Cx2ch Bus Interface, PPG SDRAM I/F, Sub-clock circuit E10A compliant
	H8SX/1653	120-pin TQFP																				84	I ² Cx2ch Bus Interface, PPG E10A compliant	
H8S/2172	100-pin TQFP	76								E10A compliant														
H8S/2472**	176-pin BGA	128								Ether Net I ² Cx6ch, synchronous serial communication x1ch CRC operation circuit Bus interface, E10A supported														
16bit	H8S/2212	64-pin LQFP 64-pin QFN	-20 to 75 (-40 to 85) ^{*1}	DMACx4ch	37	Sub-clock circuit E10A compliant	Full-Speed	FIFO Total 456Byte ^{*3} Max 128Byte	With USB Pull-up Control Terminal	Vbus Detector	9Endpoints	FIFO Total 1288Byte ^{*3} Max 265Byte ^{*4}	-	Printer, Scanner, other PC peripheral devices										
	H8S/2215	120-pin TQFP 112-pin BGA		DMACx4ch DTCx85ch	75	Bus interface Bus interface E10A supported																		
	H8S/2218	100-pin TQFP 112-pin BGA		DMACx4ch	69	Bus interface Sub Clock circuit E10A supported																		
	M30245	100-pin LQFP		83(8) ^{*2}	CRC calculation circuit (2 types) Sub Clock circuit																			
	38K0	64-pin LQFP (0.5mm pitch/0.8mm pitch)		48(4) ^{*2}	Bus Interface																			
	38K2			44(4) ^{*2}																				
8bit							Full-Speed Hub				4Endpoints 2Endpoints(Hub) + 4Endpoints(Function)	FIFO Developed in built-in RAM Max 64 Bytes ^{*4}		USB Pull-up Power Output Pin		Other PC peripheral devices								

*1: Wide temperature type *2: LED Drive Port *3: Total number of built-in FIFO *4: Maximum number of bytes allowing transmissions to and from just one endpoint. *5: Exclusive use for Host and Function

■ Hi-Speed Function ■ Full-Speed Function ■ OHCI Host ■ Renesas Original Host

ROAD MAP

SELECTION MAP

R8A66597

M66596

M66591/M66592

M66291

SH7722

SH7263
SH7203

SH7760

SH7763

SH7720
SH7721

SH7727

SH7641

SH7705

H8SX/
1668R

H8SX/
1658R

H8SX/
1653/1663

H8S/2172

H8S/2472

H8S/2212
2215/2218

M16C/24

38K0

38K2

USB IP/
ZENER DIODE

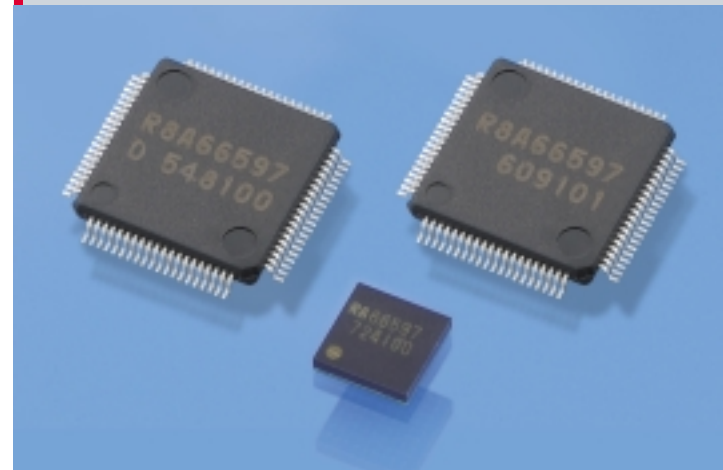
DEVELOPMENT
ENVIRONMENT

EVALUATION
PRODUCTS

EVALUATION
BOARD

Hi-Speed USB2.0 Host and Function

R8A66597FP/DFP* /BG



The R8A66597 is the USB controller that is the upper model of M66596. It is possible to select either a 2-port host function or a 1-port peripheral function by this model's register settings.

The host function enables the connection of an external HUB (up to one stage*) and communications for up to 10 devices.

The Embedded Host and the On-The-Go can be easily realized, the function has been expanded. In addition, it is now possible to incorporate a large variety of products thanks to the development of products that can tolerate a wide temperature range. This product is equipped with various functions that reduce the external circuit, so that a smaller external elemental device and space-saving mounting can be enabled.

The peripheral function on this model is compatible with the M66592. In addition, the ultra small 5mm square package (R8A66597BG) offers suitability for mobile device applications. Because the regulator (3.3V → core power supply) is incorporated, it can be operated by 3.3V single power supply.

In addition, the R8A66597 has been developed using Renesas's original USB-IP, and it can be smoothly integrated into a System LSI.

* Wide temperature type

USB Host USB Hi-Speed (Control, Interrupt, Bulk, Isochronous) 2port	USB Function USB Hi-Speed (Control, Interrupt, Bulk, Isochronous)	Maximum Number of Connectable Functions 10 Functions (Can connect up to 1 step of external HUB*)	Endpoint 10pipes (Endpoints)	Clock Input Frequency 12/24/48MHz	FIFO 2KByte (MAX) ^{*2} 8.5KByte (Total) ^{*3}	DMA Interface 2ch
Bus Interface 16-bits CPU Bus I/F, Separate/Multiplex selectable	Split Bus 8-bits Split Bus I/F	Power Source for USB Pull-up D+Pull-up Power Source (Supply Control)	PLL Frequency Multiplier Built-in	Interrupt Pins 1-pin polarity set, interrupt source can be assigned	Supply Voltage 3.3V Power Supply, I/O Power Supply	Vbus Detector USB cable connection/ disconnection detector
Built-in Resistor D+, D-Termination Resistor D+, D-Pull-down Resistor (In Host Mode) D+Pull-up Resistor(In Peripheral Mode)	Low-Power Sleep State S/W Settable	Package 80-pin QFP 81-pin LFBGA				

*1. When connected by the Full-Speed function via the Hi-Speed hub, the payload of 188 bytes or lower will be supported for Isochronous type.

*2. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.

*3. Maximum number of built-in FIFO

R8A66597 ASSP Line-up							
Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
R8A66597FP*	80	LQFP	PLQP0080LA-A	3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:70 FS:25
R8A66597DFP**	80	LQFP	PLQP0080LA-A	3.3	1.6 to 2.0/2.7 to 3.6	-40 to 85*	HS:70 FS:25
R8A66597BG**	81	LFBGA	PLBG0081KA-A	3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:70 FS:25

* : Wide temperature type *★: New product ★★: Under development

Development/Evaluation Products ●M3A-0040: R8A66597FP Utility Board ●M3A-ZA53: Converter Board for USB ASSP Utility Board ➔ Please see P35 for details. ●M3A-0033: Renesas USB ASSP Evaluation Motherboard

Hi-Speed USB2.0 Host and Function

M66596FP/WG/UG



The M66596 is a USB controller conforming to USB2.0 specifications that are suitable for embedding applications.

During register setup, the Host and Function or peripheral function can be selected. The supported transfer speeds are Hi-Speed transfer and Full-Speed transfer, and one-to-one Hi-Speed transfer with USB peripheral occurs when the USB Host and Function is selected.

The Embedded Host can be easily realized.

The full lineup of functions reduces the number of external circuits and is also equipped to enable a reduction in external elements and allow space-saving mounting. In addition to lowering power consumption, the ultra small 5mm square package (M66596UG) is suitable for mobile device applications. The M66596 is pin-compatible with USB peripheral controller M66592 and, consequently, expansion from a USB peripheral device to a USB Host device is made simple.

In addition, the M66596 has been developed using Renesas's original USB-IP, and it can be smoothly integrated into a System LSI.

USB Host USB Hi-Speed (Control, Interrupt, Bulk, Isochronous)	USB Function USB Hi-Speed (Control, Interrupt, Bulk, Isochronous)	Maximum Number of Connectable Functions 1 Function	Endpoint 8pipes (Endpoints)	Clock Input Frequency 12/24/48MHz	FIFO 2KByte (MAX) *1 5KByte (Total) *2	DMA Interface 2ch
Bus Interface 16-bits CPU Bus I/F, Separate/Multiplex selectable	Split Bus 8-bits Split Bus I/F	Power Source for USB Pull-up D+Pull-up Power Source (Supply Control)	PLL Frequency Multiplier Built-in	Interrupt Pins 1-pin polarity set, interrupt source can be assigned	Supply Voltage 1.5V, 3.3V Power Supply, I/O Power Supply	Vbus Detector USB cable connection/ disconnection detector
Built-in Resistor D+, D-Termination Resistor D+, D-Pull-down Resistor (In Host Mode) D+Pull-up Resistor(In Peripheral Mode)	Low-Power Sleep State S/W Settable	Package 64-pin LQFP, FBGA, VFBGA				

*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.

*2. Maximum number of built-in FIFO

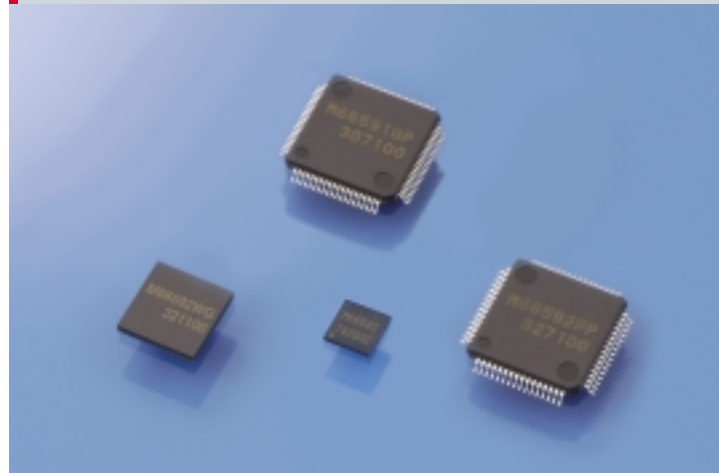
M66596 ASSP Line-up							
Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
M66596FP	64	LQFP	64P6X-B	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66596WG	64	FBGA	64FHX-A	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66596UG*	64	VFBGA	64FHX-C	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18

*★: New product

Development/Evaluation Products ●M3A-0039: M66596FP Utility Board ●M3A-ZA53: Converter Board for USB ASSP Utility Board ➔ Please see P35 for details. ●M3A-0033: Renesas USB ASSP Evaluation Motherboard

Hi-Speed USB2.0 Function

M66591GP/ M66592FP/WG/UG



USB
ASSP

The M66591 and M66592 are USB peripheral controllers embedded with a Hi-Speed/Full-Speed transceiver, compliant with USB2.0 specifications, and can operate in both Hi-Speed transfer mode and Full-Speed transfer mode.

The M66592 is a USB peripheral controller that furnishes low power consumption in an ultra small 5mm square package (M66592UG) that is suitable for mobile device applications.

The M66592 supports all transfer types of USB2.0 specifications with a 5KB FIFO that can be set at a maximum of 8 Endpoints. In addition, the 8-bit split bus (a DMA interface independent from the CPU bus) furnishes high-speed communications without stressing the CPU.

The M66591 is a peripheral controller in a small package that is specialized for bulk application. The 3.5KB FIFO can be set at a maximum of 7 Endpoints.

The M66591 and M66592 have all been developed using Renesas's original USB-IP, and each can be smoothly integrated into a System LSI.

Full-Speed USB2.0 Function

M66291GP/HP



USB
ASSP

The M66291 is a USB peripheral controller in compliance with the Full-Speed USB2.0 and equipped with Full-Speed transceiver. It supports all USB2.0 transfer types with the 3KB FIFO settable to a maximum of 7 Endpoints. It also supports a variety of DMA modes thanks to the built-in DMA interface (2-ch) and features selectable polarity. In addition, the M66291 comes equipped with 2 interrupt pins, selectable polarity, and interrupt source options. Connection to a CPU with a 5V power supply is available because the I/O power supply is 2.7 to 5.5V. The M66291 was developed using Renesas's original USB-IP, and it will be able to smoothly integrate System LSI.

USB Function USB Hi-Speed (Control, Interrupt, Bulk, Isochronous) (M66592) (Control, Interrupt, Bulk) (M66591)	Endpoint 7pipes (Endpoints) (M66591) 8pipes (Endpoints) (M66592)	Clock Input Frequency 12/24/48MHz	FIFO 512KByte (MAX) *1 3.5KByte (Total) *2 (M66591) 2KByte (MAX) *1 5KByte (Total) *2 (M66592)	DMA Interface 2ch (M66592) 1ch (M66591)	Bus Interface 16 bits CPU Bus I/F Separate/Multiplex selectable (M66591)	Split Bus 8 bit Split Bus I/F (M66592)
Power Source for USB Pull-up D+Pull-up Power Source (Supply Control)	PLL Frequency Multiplier Built-in	Interrupt Pins 1-pin polarity set, interrupt source can be assigned (M66592 Fix to polarity)	Supply Voltage 3.3V Power Supply, I/O Power Supply, (M66591) 1.5V, 3.3V Power Supply, I/O Power Supply, (M66592)	Vbus Detector USB cable connection/ disconnection detector	Built-in Resistor D+, D-Termination Resistor D+Pull-up Resistor (M66592)	Low-Power Sleep State S/W Settable (M66592)
Package 80-pin LQFP (M66591) 64-pin LQFP, FBGA, VFBGA (M66592)	USB Power Management Output Function Configured Condition (M66591) Suspend Condition (M66591)					

*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
 *2. Maximum number of built-in FIFO
 *3. EP1-2=Bulk, 512 Byte double-buffer EP3-4=Bulk, 512 Byte single-buffer EP5-6=Interrupt in 64 Byte single-buffer

Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (C)	Current Consumption (mA)
M66591GP	80	LQFP	PLQP0080LA-A	3.3	1.7 to 2.0/2.7 to 3.6	-20 to 85	184
M66592FP	64	LQFP	64P6X-B	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66592WG	64	FBGA	64FHX-A	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66592UG*	64	VFBGA	64FHX-C	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18

*: New product

Development/Evaluation Products	●M3A-0037G01:M66591GPUtility Board ●M3A-0038G01:M66592FPUtility Board	●M3A-0033: Renesas USB ASSP Evaluation Motherboard ●M3A-ZA53: Converter Board for USB ASSP Utility Board	➔ Please see P35 for details
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USB Function USB Full-Speed (Control, Interrupt, Bulk, Isochronous)	Endpoint 7Endpoints	Clock Input Frequency 6/12/24/48MHz*3	FIFO 1KByte (MAX) *1 3KByte (Total) *2	DMA Interface 2ch polrdity set, 8/16 bit correspondence	BUS Interface 8/16 bits CPU	Power Source for USB Pull-up D+Pull-up Power Source (Supply Control)
PLL Frequency Multiplier Built-in	Interrupt Pins 2-pin polarity set, interrupt source can be assigned	Supply Voltage 3.3V, I/O 2.7 to 3.6V/ 4.5 to 5.5V	Vbus Detector USB cable connection/ disconnection detector	Package 48-pin LQFP, 52-pin VQFN		

*1. Maximum number of bytes allowing set to just one Endpoint. Using the double buffer mode doubles transmission capability.
 *2. Total number of built-in FIFO
 *3. When I/O voltage=2.7 to 3.6V, clock input is 6/12/24/48MHz. When I/O voltage=4.5 to 5.5V, clock input is 24/48MHz.

Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (C)	Current Consumption (mA)
M66291GP	48	LQFP	PLQP0048KB-A	3.3	2.7 to 3.6/4.5 to 5.5	-20 to 85	15
M66291HP	52	VQFN	PVQN0052LA-A	3.3	2.7 to 3.6/4.5 to 5.5	-20 to 85	15

Development/Evaluation Products	●M3A-0032: M66291GP Utility Board ●M3A-0033: Renesas USB ASSP Evaluation Motherboard	●M3A-ZA53: Converter Board for USB ASSP Utility Board	➔ Please see P35 for details
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Hi-Speed USB2.0 Function

SH7780 Series SH7722



32 bit

The SH7722 is a 32-bit RISC microprocessor embedded with a USB Function conforming to Hi-Speed USB2.0 specifications. The operation is available at up to 333MHz, as well as various multimedia support functions such as accelerators with MPEG4·H.264, and 2D graphics, an LCD controller, a camera interface, and sound I/O, as core functions, plus CPU- and DSP-expanded functions of SuperH architecture.

The USB module supports all transfer types with USB2.0 specifications with a 4KB FIFO that can be set to a maximum of eight Endpoints.

The SH7722 is suitable for multimedia equipment that simultaneously requires high performance and low power, such as one-segment supported auto navigation equipment or portable media players.

 USB Function USB Hi-Speed (Control, Interrupt, Bulk, Isochronous) 8 Endpoints	 Vbus Detector USB cable connection/disconnection detector	 FIFO 4KByte FIFO	 Cache Memory and Built-in RAM 64KByte Cache 16KByte RAM	 MMU 4Way 128Entry	 VPU H.264/MPEG4 Encode / decode	 JPU JPEG Encode / decode
 LCDC TFT Response 16.67 million Color Display	 DMA Controller 6 channels	 Serial I/O FIFO-equipped Serial Interface X2ch Clock Sync. Serial X1ch UART/Clock Sync. X3ch	 General-purpose Timer 32bit X2 16bit X4	 Bus State Controller Flash, ROM, Page ROM, SRAM, PCMCIA (X32/X16)	 SDRAM Dedicated Controller SDRAM (X64/X32/X16)	 Watchdog Timer 1 channel
 RTC 1 channel Clock/Calendar	 H-UDI JTAG Debug Interface	 I/O Ports 149	 Supply Voltage Internal: 1.15 to 1.3V External: 3.1 to 3.6V	 Package BGA449		

SH7722 MCU Line-up

Part Number	Pin	Package	Package Code	Cache Built-in RAM (Byte)	Clock (MHz)(MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
R8A77220AC266BGV*	449	BGA	PRBG0449GA-A	64KB/128KB	266 333	19	1.15 to 1.3/3.0 to 3.6 1.25 to 1.35/3.0 to 3.6	-20 to 70 -40 to 85	0.75mW/MHz

*: New product

Development/Evaluation Products ●MS7722SE01:SH7722 Solution Engine ➔ Please see P34 for details.

Hi-Speed USB2.0 Host/Function

SH7260/SH7200 Series SH7263/SH7203



32 bit



The SH7263/7203 is a 32-bit RISC microprocessor embedded with USB Host and Function conforming to Hi-Speed USB2.0 specifications. In addition to the 200MHz SH2A-FPU core, 16KB cache memory, and 80KB internal RAM, the device features abundant peripheral functions such as color LCDC, DMAC, audio interface, CDROM decoder, sampling rate converter, and other peripheral functions.

The USB module complies with all transfer types of USB2.0 specifications and is capable of setting the 8KB FIFO up to 8 endpoints. SH7263 is the best choice for digital audio devices such as car audio and home audio, and SH7203 is the best choice for industrial devices such as sequencers, robots, and other devices.

 USB Function USB Hi-Speed & Full-Speed (Control, Interrupt, Bulk, Isochronous) 8 Endpoints	 USB Host USB Hi-Speed & Full-Speed (Control, Interrupt, Bulk, Isochronous)	 Maximum Number of Connectable Functions 1 Function	 SDHI 1bit/4bit SD bus	 Sampling rate converter 1 channel	 CD-ROM decoder 1 channel	 Cache Memory and Built-in RAM 32KB Cache 16KB RAM
 CAN Controller 2 channels	 AND/NAND flash memory controller Max. 4-Gbit	 LCDC TFT, STN, DSTN Response 65536 Color Display	 DMA Controller 8 channels	 Serial I/O FIFO-equipped UART/Clock x 4ch Clock Sync x 2ch I ² C x 4ch Sound Interface x 4ch	 General-purpose Timer 16bit x 7	 Bus State Controller Flash ROM, Page ROM, SRAM, SDRAM, PCMCIA
 Watchdog Timer 1 channel	 RTC 1 channel Clock/Calendar Function	 A/D, D/A Converter A/D 10bit x 8ch D/A 8bit x 2ch	 H-UDI JTAG Debug Interface	 I/O Ports 99	 Supply Voltage Internal: 1.1 to 1.3V External: 3.0 to 3.6V	 Package QFP240 (32mm)

SH7263/SH7203 MCU Line-up

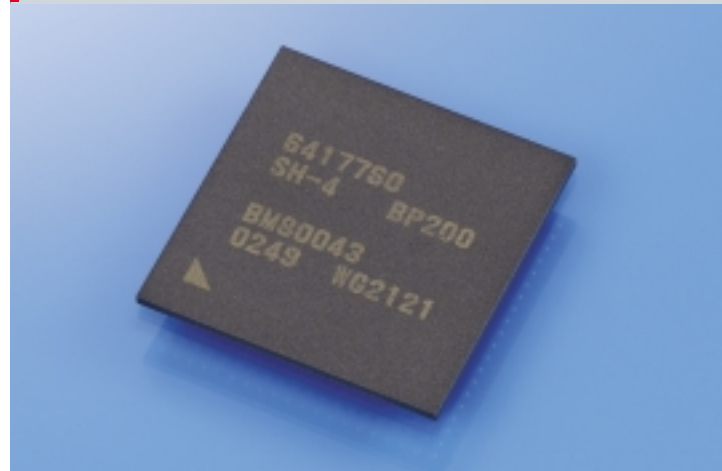
Part Number	Pin	Package	Package Code	Cache Built-in RAM (Byte)	Clock (MHz)(MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
R5S72630P200FP*	240	QFP	QFP3232-240Cu	16KB/80KB	200	5.0	1.1 to 1.3/3.0 to 3.6	-40 to 85	TBD
R5S72631P200FP*									
R5S72632P200FP*									
R5S72633P200FP*									
R5S72030P200FP*	240	QFP	QFP3232-240Cu	16KB/80KB	200	5.0	1.1 to 1.3/3.0 to 3.6	-20 to 85	TBD

*: New product

Development/Evaluation Products ●R0K572630D000BR:SH7263Evaluation Board ➔ Please see P34 for details.

Full-Speed USB (OHCI1.0 Host)

SH7750 Series SH7760



32 bit

The SH7760 is the 32-bit RISC microprocessor embedded with the USB Host with Low-Speed and Full-Speed OHCI1.0 specifications. In addition to the SH-4 core with the highly efficient floating point arithmetic unit, 16KB instruction cache memory and 32KB data cache memory, the device features abundant peripheral functions such as 65536-color LCDC, DMAC, UART with FIFO, audio interface, 32-bit automatic reloading timer, WDT, etc. An external bus interface can control FLASH, SRAM, byte control SRAM and SDRAM. All this makes the device the best choice for electric devices because of the simple navigation system, color liquid crystal-equipped POS terminal and audio apparatus.

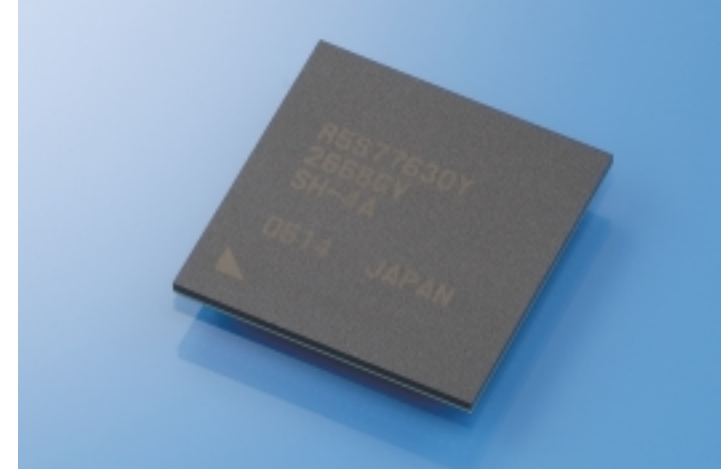
USB Host USB Full-Speed & Low-Speed (Control, Interrupt, Bulk, Isochronous)	Host-shared Memory (USB Host) Built-in 8KB Memory Use Possible	Cache Memory Instruction: 16KByte Data: 32KByte	MMU Instruction: 4Entry Data: 64Entry	LCDC TFT, STN, DSTN 65536 Color Display	DMA Controller 8 channels	Bus State Controller Flash, Page ROM, SRAM, SDRAM, Byte control SRAM, PCMCIA, MPX
Serial I/O FIFO-equipped UART/ Clock sync x 3ch Audio Interface x 2ch	A/D Converter A/D 10bit x 4ch	General-purpose Timer 32bit x 3	I²C Bus 1 channel Continuous Reception/ Transmission Capability	Watchdog Timer 1 channel	UBC 2ch Sequential Break Function	H-UDI JTAG Debug Interface
I/O Ports 70	Supply Voltage Internal: 1.4 to 1.6V I/O: 3.0 to 3.6V (with operation 200MHz)	Package BGA256				

SH7760 MCU Line-up									
Part Number	Pin	Package	Package Code	Cache (Instruction/Data) (Bytes)	Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
HD6417760BL200ADV	256	BGA	PLBG0256GB-A	16K/32K	200	2.5	1.4 to 1.6/3.0 to 3.6	-40 to 85	330/200 (typ, Core)
HD6417760BL200AV	256	BGA	PLBG0256GB-A	16K/32K	200	2.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	330/200 (typ, Core)

Development/Evaluation Products ●MS7760CP02P:SH7760 Solution Engine 2 ➔ Please see P34 for details.

Full-Speed USB2.0 Function&OHCI1.0 Host

SH7700 Series SH7763



32 bit

The SH7763 is the 32-bit RISC microprocessor embedded with USB Function conforming to Full-Speed USB2.0 specifications and USB Host of Low-Speed and Full-Speed OHCI1.0 specifications. In addition to the high-performance SH-4A core, 64KB cache memory and 16KB internal RAM, the device features abundant peripheral functions such as gigabit Ethernet controller, PCI bus controller, security accelerator, color LCDC, DMAC, RTC, WDT, and others. System development is simple so that USB Function can process the USB standard commands, and the USB State nearly fully automatically uses the hardware. With the bulk endpoint engineered with a double-buffer composition, high-speed data transmission is a reality. All this and more make the device the best choice for electric devices, such as network devices, IT terminals, and digital appliances.

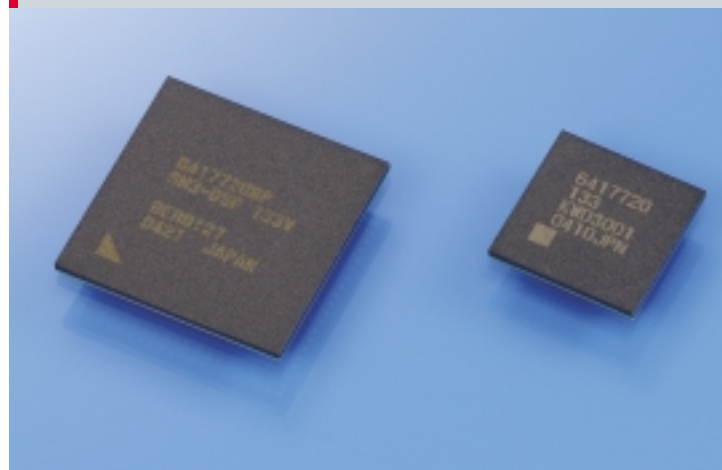
USB Function USB Full-Speed (Control, Interrupt, Bulk, Isochronous) 6 Endpoints	USB Host USB Full-Speed & Low-Speed (Control, Interrupt, Bulk, Isochronous) 127 Endpoints	Vbus Detector USB cable connection/ disconnection detector	FIFO (USB Function) 544Byte Bulk Endpoint: Double Buffer	USB State Control (USB Standard Command Processing) (USB Function) H/W Automatic Processing (Partial Software Processing)	Cache Memory and Built-in RAM 64KByte Cache 16KByte RAM	MMU 4Way 128Entry
Security Accelerator CES, Triple-DES code/ Decryption	LCDC TFT, STN, DSTN Response 65536 Color Display	DMA Controller 6 channels	Serial I/O FIFO-equipped UART/ Clock Sync. x 3ch Audio Interface x 3ch	General-purpose Timer 32bit x 6 16bit x 4	Host-shared Memory DDR-SRAM	Gigabit EtherNet controller 2 channels
PCI Bus Controller	DDR-SDRAM Controller	Bus State Controller Flash, ROM, Page ROM, SRAM, PCMCIA	Watchdog Timer 1 channel	RTC 1 channel Clock/Calendar	A/D, D/A Converter A/D 10 bits x 4 channels D/A 8 bits x 2 channels	H-UDI JTAG Debug Interface
I/O Ports 117	Supply Voltage Internal : 1.1 to 1.3V External : 3.0 to 3.6V DDR : 2.3 to 2.7V	Package BGA449				

SH7763 MCU Line-up										
Part Number	Pin	Package	Package Code	Cache Built-in RAM (Byte)	Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Current Consumption (mA/MHz)	Other
R5S77630Y-266BGV★	449	BGA	PRBG0449GA-A	64KB/16KB	266	1.9	1.15 to 1.35/3.0 to 3.6/2.3 to 2.7	-20 to 75	950/266 (typ, Core)	With cipher
R5S77631Y-266BGV★	449	BGA	PRBG0449GA-A	64KB/16KB	266	1.9	1.15 to 1.35/3.0 to 3.6/2.3 to 2.7	-20 to 75	950/266 (typ, Core)	Without cipher
R5S77632Y-266BGV★	449	BGA	PRBG0449GA-A	64KB/16KB	266	1.9	1.15 to 1.35/3.0 to 3.6/2.3 to 2.7	-20 to 75	950/266 (typ, Core)	With cipher SD Card I/F with cipher

★: New product

SH7700 Series

SH7720/SH7721



32 bit

The SH7720/SH7721 is a 32-bit RISC MCU embedded with USB Function that conforms to Full-Speed USB2.0 specifications and includes both USB Host Low-Speed and Full-Speed OHCI1.0 specifications. In addition to its high performance SH3-DSP core, 32KB cache memory, and 16KB internal RAM, this device features many peripheral functions, such as an SSL security (SH7720 only), color LCDC with 65536-color display DMAC, audio interface, RTC, and WDT. System development is simple, because of allowing the USB Function to process USB standard commands and virtually automatic USB operation using the hardware. With a bulk endpoint engineered with a double-buffer composition, high-speed data transmission is a reality. This device is the best choice for electrical equipment, such as a color liquid crystal equipped FAX, a direct printer, IP telephones, and audio apparatus.

USB Function USB Full-Speed (Control, Interrupt, Bulk, Isochronous) 6 Endpoints	USB Host USB Full-Speed & Low-Speed (Control, Interrupt, Bulk, Isochronous) 127 Endpoints	Vbus Detector USB cable connection/ disconnection detector	FIFO (USB Function) 544Byte Bulk Endpoint: Double Buffer	USB State Control USB Standard Command Processing(USB Function) H/W Automatic Processing (Partial Software Processing)	Cache Memory and Built-in RAM 32KByte Cache 16KByte RAM	MMU 4Way 128Entry
SSL Accelerator RSA, DES, Triple-DES code/ Decryption	LCDC TFT, STN, DSTN Response 65536 Color Display	DMA Controller 6 channels	Serial I/O FIFO-equipped UART/ Clock Sync. x 2ch Audio Interface x 2ch	General-purpose Timer 32bit x 3 16bit x 4	Bus State Controller Flash, ROM, Page ROM, SRAM, PCMCIA, SDRAM	Watchdog Timer 1 channel
RTC 1 channel Clock/Calendar	A/D, D/A Converter A/D 10 bits x 4 channels D/A 8 bits x 2 channels	H-UDI JTAG Debug Interface	I/O Ports 117	Supply Voltage Internal : 1.4 to 1.6V External : 3.0 to 3.6V	Package CSP256 (17mm□) CSP256 (11mm□)	Host-shared Memory(USB Host) SRAM, SDRAM, XYRAM Space Use Possible

SH7720/SH7721 MCU Line-up										
Part Number	Pin	Package	Package Code	Cache Built-in RAM (Byte)	Clock (MHz)(MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Current Consumption (mA/MHz)	other
HD6417720BP133CV	256	CSP	PLBG0256GA-A	32K/16K	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	with SSL
HD6417720BL133CV	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	
HD6417320BP133CV	256	CSP	PLBG0256GA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	with SSL
HD6417320BL133CV	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	SD card I/F
HD6417321BP133CV	256	CSP	PLBG0256GA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	with SSL
HD6417321BL133CV	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	MS card I/F
HD6417330BP133CV	256	CSP	PLBG0256GA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	with SSL
HD6417330BL133CV	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	SD card I/F
R8A77210C133BGV *	256	CSP	PLBG0256GA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	without SSL
R8A77210C133BAV *	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	
R8A77211C133BGV *	256	CSP	PLBG0256GA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	without SSL
R8A77211C133BAV *	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	SD card I/F
R8A77212C133BGV *	256	CSP	PLBG0256GA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	without SSL
R8A77212C133BAV *	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	MS card I/F
R8A77213C133BGV *	256	CSP	PLBG0256GA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	without SSL
R8A77213C133BAV *	256	CSP	PLBG0256KA-A	32K/16KB	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	230/133(typ. Core)	SD, MS card I/F

*: New product

Development/Evaluation Products

●MS7720RP02:SH7720 Solution Engine Light

➔ Please see P34 for details.

SH7700 Series

SH7727



32 bit



The SH7727 is a 32-bit RISC microprocessor embedded with USB Function conforming to Full-Speed USB2.0, and USB Host compatible with Low-Speed and Full-Speed OHCI1.0. In addition to high-performance SH3-DSP core, 16KB large-capacity cache memory and 16KB internal RAM, the unit features a color LCDC with 65536 color display capacity, DMAC, audio interface, RTC, WDT and other abundant peripheral functions. For the USB Module, because the USB standard commands and USB state are processed nearly fully automatically with hardware, system development is simple. With the bulk Endpoint engineered with double-buffer mode, high-speed data transmission becomes a reality. All this and more make this MCU the best choice for color liquid crystal equipped FAX machines, direct printers, audio equipment and other sophisticated electronic equipment.

USB Function USB Full-Speed (Control, Interrupt, Bulk) 4 Endpoints	USB Host USB Full-Speed & Low-Speed (Control, Interrupt, Bulk, Isochronous) 127 Device Address 16X2 Endpoints	Vbus Detector USB cable connection/ disconnection detector	FIFO (USB Function) 288 Bytes Bulk Endpoint: Double Buffer	Host-shared Memory(USB Host) Area 3 SDRAM Space Use Possible	USB State Control USB Standard Command Processing(USB Function) H/W Automatic Processing (Partial Software Processing)	Cache Memory and Built-in RAM 16K Bytes Cache 16K Bytes RAM
MMU 4 Way 256 Entry	LCDC TFT, STN, DSTN Response 65536 Color Display	DMA Controller 4 channels	Serial I/O UART/Clock Sync. x 1ch FIFO-equipped UART x 1ch Audio Interface x 1ch	General-purpose Timer 32 bits x 3	Bus State Controller Flash, ROM, Page ROM, SRAM, PCMCIA, SDRAM	Watchdog Timer 1 channel
RTC 1 channel Clock/Calendar	A/D, D/A Converter A/D 10 bits x 6 channels D/A 8 bits x 2 channels	H-UDI JTAG Debug Interface	I/O Ports 104	Supply Voltage Internal: 1.75 to 20.5V External: 3.0 to 3.6V (160MHz operating)	Package HQFP240 CSP240	

SH7727 MCU Line-up									
Part Number	Pin	Package	Package Code	Cache Built-in RAM (Byte)	Clock (MHz)(MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
HD6417727F160C	240	HQFP	PRQP0240KC-B	16K/16K	160	6.25	1.75 to 2.05/3.0 to 3.6	-20 to 75	627/160
HD6417727F100C				16K/16K	100	10.0	1.6 to 2.05/2.6 to 3.6	-20 to 75	475/100
HD6417727BP160C	240	CSP	PLBG0240JA-A	16K/16K	160	6.25	1.75 to 2.05/3.0 to 3.6	-20 to 75	627/160
HD6417727BP100C				16K/16K	100	10.0	1.6 to 2.05/2.6 to 3.6	-20 to 75	475/100

Development/Evaluation Products

●MS7727RP03:SH7727 Solution Engine Light

➔ Please see P34 for details.

Full-Speed USB2.0 Function

SH7641 Series SH7641



32 bit

The SH7641 is a 32-bit RISC microcomputer embedded with USB Function, conforming to Full-Speed USB2.0 specifications. In addition to high-performance SH3-DSP core and 16KB large-capacity cache memory, the device features 144KB large-capacity SRAM, DMAC, serial interface, I²C, WDT, multi-function timer unit and other abundant peripheral functions. The external bus interface may be directly connected to Flash, ROM, SRAM and byte-select SRAM, as well as to SDRAM. For the USB Module, because the USB standard commands and USB state are processed nearly fully automatically with hardware, system development is simple. With the bulk Endpoint engineered with a double-buffer mode, high-speed data transfer becomes a reality. Also provided is a sleep mode and module standby mode to shut down the CPU during idling, along with other outstanding built-in power management functions. All this makes the SH7641 the optimum MCU for fields that demand high speed and low-power consumption in a single package.

USB Function USB Full-Speed (Control, Interrupt, Bulk)	Vbus Detector USB cable connection/disconnection detector	Endpoint 4 Endpoints	FIFO 288 Bytes Bulk Endpoint: Double Buffer	USB State Control USB Standard Command Processing H/W Automatic Processing (Partial Software Processing)	Built-in RAM Large capacity 144K Bytes	Cache Memory 16K Bytes Instruction/Data Mix
DMA Controller 4 channels	Serial I/O 16 Bytes FIFO UART/Clock Sync. x 3ch	General-purpose Timer 16 bits x 2	Multiple Timer 16 bits x 5 (PWM)	Bus State Controller Flash, ROM, Page ROM, SRAM, Byte Select SRAM, SDRAM	Watchdog Timer 1 channel	I²C Bus 1 channel Continuous Reception/Transmission Capability
A/D Converter 10 bits x 8 channels	H-UDI JTAG Debug Interface	UBC 2 channel Sequential Break Function	I/O Ports 164	Supply Voltage Internal: 1.7 to 1.9V External: 3.0 to 3.6V	Package LFBGA256	

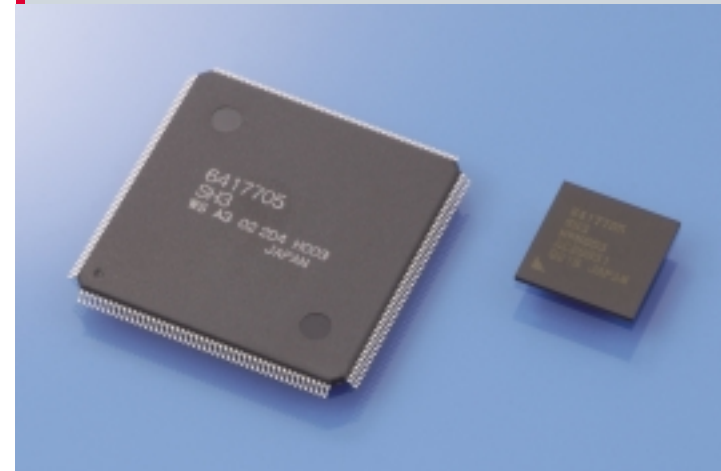
SH7641 MCU Line-up										
Part Number	Pin	Package	Package Code	Cache Built-in RAM (Byte)	Clock (MHz)(MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)	
HD6417641BP100	256	LFBGA	CSP256pin	16K/144K	100	100	1.7 to 1.9/3.0 to 3.6	-40 to 85	640/100	

Full-Speed USB2.0 Function

SH7700 Series SH7705



32 bit



The SH7705 is a 32-bit RISC microprocessor with embedded USB Function, conforming to Full-Speed USB2.0 specifications. In addition to high-performance SH-3 core and 32KB large-capacity cache memory, the device features built-in DMAC, serial interface, IrDA 1.0, RTC, WDT and other abundant peripheral functions. The external bus interface may be directly connected to Flash, ROM, SRAM and byte-select SRAM, as well as 512Mbit large-capacity SDRAM. For the USB Module, because the USB standard commands and USB state are processed nearly fully automatically with hardware, system development is simple. With the bulk Endpoint engineered in a double-buffer mode, high-speed data transmission becomes a reality. Also provided is a sleep mode and module standby mode to shut down the CPU during idling, along with other outstanding internalized power management functions. In short, this MCU is the best choice for mobile terminals that demand high speed and low-power consumption in a single package.

USB Function USB Full-Speed (Control, Interrupt, Bulk)	Vbus Detector USB cable connection/disconnection detector	Endpoint 4 Endpoints	FIFO 288Byte Bulk Endpoint: Double Buffer	USB State Control USB Standard Command Processing H/W Automatic Processing (Partial Software Processing)	Cache Memory 32KByte Instruction/Data Mix	MMU 4 Way 128 Entry
DMA Controller 4 channels	Serial I/O 64 Bytes FIFO UART/Clock Sync. x 2ch (IrDA1.0 x 1ch)	General-purpose Timer 32 bits x 3	Multiple Timer 16 bits x 4 (PWM)	Bus State Controller Flash, ROM, Page ROM, SRAM, Bytes Select SRAM, SDRAM	Watchdog Timer 1 channel	RTC 1 channel Clock/Calendar Function
A/D Converter 10 bits x 4 channels	H-UDI JTAG Debug Interface	UBC 2 channel Sequential Break Function	I/O Ports 105	Supply Voltage Internal: 1.4 to 1.6V External: 3.0 to 3.6V	Package LQFP208 CSP208	

SH7705 MCU Line-up										
Part Number	Pin	Package	Package Code	Cache Memory (Bytes)	Clock (MHz)(MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)	
HD6417705F133B	208	LQFP	PLQP0208KA-A	32K	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	200/133	
HD6417705F100B			PLQP0208KA-A	32K	100	10.0	1.4 to 1.6/3.0 to 3.6	-20 to 75	157/100	
HD6417705BP133B	208	CSP	TTBG0208JA-A	32K	133	7.5	1.4 to 1.6/3.0 to 3.6	-20 to 75	200/133	
HD6417705BP100B			TTBG0208JA-A	32K	100	10.0	1.4 to 1.6/3.0 to 3.6	-20 to 75	157/100	

Full-Speed USB2.0 Function

H8SX Family

H8SX/1668R Group



Flash 32 bit

The H8SX/1668R group contains 32-bit CISC MCUs embedded with a USB Function conforming to Full-Speed USB2.0 specifications. These products mount high-speed H8SX CPU cores with a maximum operation frequency of 50MHz. They incorporate large 1MB/512KB/384KB flash memories and 56KB/40KB of RAM. This H8SX/1663 product group offers pin function upward compatibility and peripheral functions, such as AD, TPU, and EXDMAC, are strengthened, which provides an optimum solution to wide-ranging areas, such as consumer, industrial, and OA equipment. The combination with Secure IC enables applications in areas that require tamper resistance, such as POS terminals and IC card transaction terminals.

System development is simple and allows the USB module to process USB standard commands and virtually automatic USB operation using the hardware. Three transfer modes (Control, Bulk, and Interrupt) are supported, and with a bulk endpoint engineered with a double-buffer composition, high-speed data transmission becomes a reality.

In addition to the full emulator, the E10A-USB on-chip emulator conforming to JTAG I/F is also prepared, making it possible to select the development environment according to the user's needs.

USB Function USB Full-Speed (Control, Interrupt, Bulk)	Endpoint 4 Endpoints Dedicated FIFO	Vbus Detector USB cable connection/disconnection detector	FIFO 288Byte (Total)	USB State Control USB Standard Command Processing H/W Automatic Processing (Partial Software Processing)	DMA Controller EXDMAC 4ch DMAC 4ch	DTC
Serial Interface UART/Clock Sync. x 4ch Smart Card 6ch High Speed SCI 2ch	I²C Bus 2 channels	A/D Converter 10bit x 8channels (4ch x 2Unit)	D/A Converter 8bit x 2channels	Timer 16 bits x 12 8 bits x 8	Watchdog Timer 1 channel	PPG 16bit + 16bit
JTAG Debug Interface HUDI	PLL Frequency Multiplier Built-in USB48MHz generated internally	Minimum Instruction Execution Time 20 ns	Supply Voltage 3.0 to 3.6V	I/O Ports 101	Package LQFP-144	Bus State Controller SDRAM I/F

H8SX/1668R Group MCU Line-up										
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM	RAM					
R5F61668RFPV **	144	LQFP	PLQP0144KA-A	1MB	56KB	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)	TBD
R5F61664RFPV **	144	LQFP	PLQP0144KA-A	512KB	40KB	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)	TBD
R5F61663RFPV **	144	LQFP	PLQP0144KA-A	384KB	40KB	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)	TBD

** : Under development

Full-Speed USB2.0 Function

H8SX Family

H8SX/1658R Group



Flash 32 bit

The H8SX/1658R group contains 32-bit CISC MCUs embedded with a USB Function conforming to Full-Speed USB2.0 specifications. These products mount high-speed H8SX CPU cores with 50MHz maximum operation frequencies and incorporate large 1MB/512KB/384KB flash memories and 56KB/40KB RAM. This H8SX/1653 product group offers pin function upward compatibility and peripheral functions, such as AD, TPU, and EXDMAC, are strengthened, which provides an optimum solution to wide-ranging areas, such as consumer, industrial, and OA equipment. The combination with Secure IC enables applications in areas that require tamper resistance, such as POS terminals and IC card transaction terminals.

System development is simple and allows the USB module to process USB standard commands and virtually automatic USB operation using the hardware. Three transfer modes (Control, Bulk, and Interrupt) are supported, and with a bulk endpoint engineered with a double-buffer composition, high-speed data transmission becomes a reality.

In addition to the full emulator, the E10A-USB on-chip emulator conforming to JTAG I/F is also prepared, making it possible to select the development environment according to the user's needs.

USB Function USB Full-Speed (Control, Interrupt, Bulk)	Endpoint 4 Endpoints Dedicated FIFO	Vbus Detector USB cable connection/disconnection detector	FIFO 288Byte (Total)	USB State Control USB Standard Command Processing H/W Automatic Processing (Partial Software Processing)	DMA Controller EXDMAC 2channel DMAC 4channel	DTC
Serial Interface UART/Clock Sync. x 4ch UART x 2ch Smart Card 6ch High Speed SCI2 2ch	I²C Bus 2channel	A/D Converter 10bit x 8ch (4ch x 2Unit)	D/A Converter 8bit x 2channel	Timer 16bit x 12 8bit x 8	Watchdog Timer 1channel	PPG 8bit + 16bit
JTAG Debug Interface HUDI	PLL Frequency Multiplier Built-in (USB48MHz generated internally)	Minimum Instruction Execution Time 20ns	Supply Voltage 3.0 to 3.6V	I/O Ports 84	Package LQFP-120	

H8SX/1658R Group MCU Line-up										
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM	RAM					
R5F61658RFPV **	120	LQFP	PLQP0120LA-A	1MB	56KB	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)	TBD
R5F61654RFPV **	120	LQFP	PLQP0120LA-A	512KB	40KB	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)	TBD
R5F61653RFPV **	120	LQFP	PLQP0120LA-A	384KB	40KB	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)	TBD

** : Under development

Full-Speed USB2.0 Function

H8SX Family

H8SX/1653/1663 Group

Flash 32 bit

The H8SX/1653/1663 Group consists of embedded 32-bit CISC microcomputers with USB function and conforming to the Full-Speed USB2.0 specifications. They are equipped with a high-speed H8SX CPU core with maximum operational frequency of 50MHz, and includes a built-in large-capacity flash memory of 512K/384KB and RAM of 40KB. Equipped with abundant peripheral functions such as a high-speed data transfer function, SCI (compliant with Smart Card I/F and High-Speed SCI), timer, and A/D and D/A, they offer optimum solutions for a wide range of fields such as public welfare, industry, and OA devices. By combining with a Secure IC, it can be applied to fields in which tamper-proof operation is required, such as POS or IC card settlement terminals. For the USB module, because the USB standard commands and state are processed nearly fully automatically with hardware, system development is simple. Support is furnished for 3-type (Control, Bulk, and Interrupt) transfer modes, and because the bulk Endpoint is engineered with a double-buffer configuration, high-speed data transfer is possible. Likewise, because the JTAG I/F-compliant, on-chip emulator E10A is prepared, in addition to the full emulator, the development environment is selectable to suit user requirements.

Hi-Speed USB2.0 Function

H8S Family

H8S/2172 Group

Flash 16 bit

The H8S/2172 group is the 16-bit single chip microprocessor with an H8S2000 CPU core and contains a USB Function control unit (Control, Interrupt, Bulk transmission) conforming to Hi-Speed USB2.0 specifications. In addition to the USB2.0 interface, this CPU has Memory Stick PRO I/F and can process data transmission between USB and Memory Stick PRO efficiently and speedily. These devices are the best choice for note PCs, memory card readers and other PC peripherals.



USB Function USB Full-Speed (Control, Interrupt, Bulk)	Vbus Detector USB cable connection/disconnection detector	Endpoint 4 Endpoints	FIFO 288Byte (Total) 64Byte (MAX)	USB State Control USB Standard Command Processing H/W Automatic Processing (Partial Software Processing)	DMA Controller 4 channels	DTC
Serial Interface UART/Clock Sync: x 4ch UART x 2ch Smart Card 6ch High Speed SCI 2ch	I²C Bus 2 channels	A/D Converter 10bit x 8channels	D/A Converter 8bit x 2channels	Timer 16 bits x 6 8 bits x 2	Watchdog Timer 1 channel	PPG 8 bits (H8SX/1653Group) 16 bits (H8SX/1663Group)
H-UDI JTAG Debug Interface	PLL Frequency Multiplier Built-in USB48MHz generated internally	Minimum Instruction Execution Time 20 ns	Supply Voltage 3.0 to 3.6V	I/O Ports 84 (H8SX/1653Group) 101 (H8SX/1663Group)	Package TQFP-120 (H8SX/1653Group) LQFP-144 (H8SX/1663Group)	Bus State Controller SDRAM I/F (H8SX/1663Group)

USB Function USB Hi-Speed (Control, Interrupt, Bulk)	Vbus Detector USB cable connection/disconnection detector	Endpoint 4 Endpoints	FIFO 5 FIFO (interactive) 512 Bytes x 2 64 Bytes x 2	DMA Controller 4 channels	SCI Flash write-only serial 1 channel	Timer 8 bits x 2 Internal interrupt 16 bits x 3
I/O Ports 8 bits input/output: 72 ports 4 bits input/output: 4 ports	Interrupt Factor Internal: 10 External: 19	Minimum Instruction Execution Time 30.3 ns	Package 100-pin TQFP	Supply Voltage 3.0 to 3.6V	PLL Frequency Multiplier Built-in x 2	Watchdog Timer 1 channel
H-UDI JTAG Debug Interface						

Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM (Byte)	RAM (Byte)					
R5F61654FTV	120	LQFP	PTQP0120LA-A	512K	40K	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)*	248
R5F61653FTV				384K	40K	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)*	248
R5F61664FPV	144	LQFP	PLQP0144KA-A	512K	40K	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)*	248
R5F61663FPV				384K	40K	50	20	3.0 to 3.6	-20 to 75 (-40 to 85)*	248

*: Wide temperature type

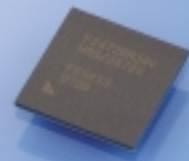
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM (Byte)	RAM (Byte)					
HD64F2170BVT6	100	TQFP	PTQP0100KA-A	256K	32K	33	30.3	3.0 to 3.6	-20 to 75	165/33

Development/Evaluation Products ● H8SX/1653/1663 Group Evaluation Board → Please see P34 for details.

Full Speed USB2.0 Function

H8S Family

H8S/2472 Group



Flash 16 bit

The H8S/2472 group contains 16-bit single chip MCUs embedded with a USB Function conforming to Full-Speed USB2.0 specifications. In addition to the high-speed CPU of internal 32-bit constituents with 34MHz (at four times greater than 8.5MHz) operation, a high capacity flash memory of 512KB, and 40KB of RAM, various peripheral functions, such as an Ethernet controller, a serial interface (the Smart Card I/F), a I²C bus, an 8-bit timer, synchronous serial communications, and a CRC operation circuit, are also incorporated. Applications with an Ethernet and USB gateways are also available.

System development is simple and allows the USB module to process USB standard commands and virtually automatic USB operation using the hardware. Three transfer modes (Control, Bulk, and Interrupt) are supported, and with a bulk endpoint engineered with a double-buffer composition, high-speed data transmission becomes a reality.

In addition to the full emulator, the E10A-USB on-chip emulator conforming to JTAG I/F is also prepared, making it possible to select the development environment according to the user's needs.

USB Function USB Full-Speed (Control, Interrupt, Bulk)	Endpoint 4 Endpoints Dedicated FIFO	Vbus Detector USB cable connection/ disconnection detector	FIFO 288Byte (Total)	USB State Control USB Standard Command Processing H/W Automatic Processing (Partial Software Processing)	DTC 85ch	Ether net Ether-C E-DMAC
Serial Interface UART/ Clock Synchronization x 2ch (Smart Card 6ch operated) UART 1ch with FIFO	Synchronous Serial Communications 1ch	I²Cbus 6ch	A/D Converter 10bit x 8ch	Timer 16bit Free-run x 1 8bits x 4 16bit PWM x 4	Watchdog Timer 2ch	CRC Operation Circuit $x^{16}+x^{15}+x^5+1$ $x^{16}+x^{15}+x^5+1$ $x^{16}+x^{15}+x^5+1$
H-UDI JTAG Debug Interface	PLL Frequency Multiplier Built-in USB48MHz generated internally	Minimum Instruction Execution Time 29ns	Supply Voltage 3.0 to 3.6V	I/O Ports 128	Package BP-176V	

H8S/2472 Group MCU Line-up										
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM	RAM					
R4F2472VBR **	176	LFBGA	PLBG0176GA-A	512KB	40KB	34	29	3.0 to 3.6	-20 to 75	TBD

** : Under development

Full-Speed USB2.0 Function

H8S Family

H8S/2212/ 2215/2218 Group



CERTIFIED USB Flash 16 bit

The H8S/2212/2215/2218 Group consists of USB function embedded 16-bit single-chip microcomputers conforming to the Full-Speed USB2.0. In addition to the high-speed CPU with built-in 32-bit configured 24MHz operation and 128KB/256KB large-capacity flash memory, these devices are internalized with DMAC, serial interface, 16-bit timer, RTC, WDT and other abundant peripheral functions. For the USB Module, because the USB standard commands and USB state are processed nearly fully automatically with hardware, system development is simple. Support is furnished for 4-type (H8S/2215 Group) and 3-type (H8S/2212, 2218 Group) transfer modes, and because the bulk Endpoint (the H8S/2215 Group has isochronous support) is engineered with a double-buffer mode, high-speed data transfer becomes a reality. Through USB, meanwhile, an onboard rewritable flash memory version is also available. With bus expansion possible, these MCUs are highly suited for PCs and OA equipment that require more memory, while the sleep mode, module standby mode and other outstanding built-in power management functions make them the optimum choices for machines that also demand low-power consumption at the same time.

USB Function USB Full-Speed (Control, Interrupt, Bulk, Isochronous (H8S/2215 only))	Vbus Detector USB cable connection/ disconnection detector	Endpoint H8S/2215: 9 Endpoints H8S/2212/2218: 4 Endpoints	FIFO H8S/2215: 1288 Bytes (Total) 256 Bytes (MAX) H8S/2212/2218: 456 Bytes (Total) 128 Bytes (MAX)	USB State Control USB Standard Command Processing H/W Automatic Processing (S/W Processing of port)	DMA Controller 4 channels	DTC H8S/2215: 85 channels
D/A Converter H8S/2215: 8bit x 2channels	A/D Converter 10 bits x 6 channels	RTC 1 channel Clock/Calendar (except H8S/2215)	Timer 16 bits x 3/8 bits x 2 (H8S/2215 only)	Watchdog Timer 1 channel	BSD Scan I/F Conforming to JTAG Debug Interface (H8S/2215, H8S/2218 FLASH only)	Serial Interface UART/clock sync x 3ch (H8S/2212/2218: 2ch) (High-speed SCI: 720kpbs x1ch)
Minimum Instruction Execution Time 41.7ns	PLL Frequency Multiplier Built-in (USB48MHz generated internally)	Supply Voltage 3.0 to 3.6V	Package LQFP64/TOFP100 TQFP120/P-LFBGA112	Smart Card Interface Built-in	H-UDI JTAG Debug Interface (H8S/2218, 2215R, and 2215T Flash version of 2212)	

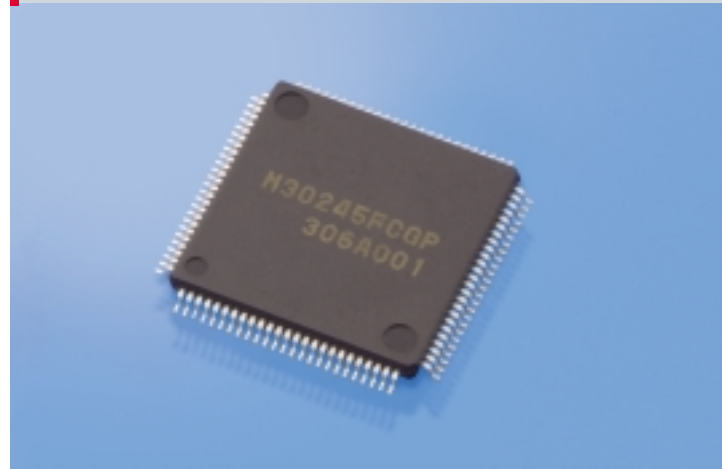
H8S/2212/2215/2218 Group MCU Line-up										
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM (Byte)	RAM (Byte)					
HD64F2212FP	64	LQFP	PLQP0064KC-A	128K	12K	24	42	3.0 to 3.6	-20 to 75 (-40 to 85) *	135/24 100/16
HD64F2211FP				64K	8K					
HD6432211(**)FP				64K	8K					
HD6432210(**)FP				32K	4K					
HD64F2215RTE	120	TQFP	PTQP0120LA-A	256K	20K	24/48	42	3.0 to 3.6	-20 to 75 (-40 to 85) *	132/24 93/16
HD64F2215TTE				256K	20K	24/48	42			
HD64F2215TE				256K	16K	16/48	62.5			
HD64F2215RBR				256K	20K	24/48	42			
HD64F2215TBR	112	P-LFBGA	PLBG0112GA-A	256K	20K	24/48	42	3.0 to 3.6	-20 to 75 (-40 to 85) *	132/24 93/16
HD64F2215BR				256K	16K	16/48	62.5			
HD6432215B(**)TE	120	TQFP	PTQP0120LA-A	128K	16K	16/48	62.5	3.0 to 3.6	-20 to 75 (-40 to 85) *	120/16
HD6432215C(**)TE				64K	8K					
HD6432215B(**)BR	112	P-LFBGA	PLBG0112GA-A	128K	16K	16/48	62.5	3.0 to 3.6	-20 to 75 (-40 to 85) *	120/16
HD6432215C(**)BR				64K	8K					
HD64F2218TF	100	TQFP	PTQP0100LC-A	128K	12K	24	42	3.0 to 3.6	-20 to 75 (-40 to 85) *	135/24 100/16
HD6432217(**)TF				64K	8K					
HD64F2218BR	112	P-LFBGA	PLBG0112GA-A	128K	12K	24	42	3.0 to 3.6	-20 to 75 (-40 to 85) *	135/24 100/16
HD6432217(**)BR				64K	8K					

*: Wide temperature type

Development/Evaluation Products ● HSB8S2215RST: H8S/2215 Group Evaluation Board ● HSB8S2218ST: H8S/2218 Group Evaluation Board ● HSB8S2215ST: H8S/2215 Group Evaluation Board ● HSB8S2212ST: H8S/2212 Group Evaluation Board ➔ Please see P34 for details.

Full-Speed USB2.0 Function

M16C/20 Series M30245



The M30245 (M16C/24 Group) consists of 16-bit single-chip MCUs with built-in USB functions in compliance with Full-Speed USB2.0. With a powerful M16C CPU embedded at the core, the M16C family boasts rich peripheral functions and handles high-speed processing with sophisticated instructions as well as its various USB control functions, such as the USB pull-up power source circuit and clock generator. The maximum 9 endpoints are equipped with FIFO to handle all USB transfer types. With the M30245, the addition of a multi-bit serial I/O enables an audio interface function, while the greater CRC calculating function enhances the memory card interface. In addition, other steps facilitating audio application are implemented, making this system simple to configure for use in memory card application fields. Meanwhile, the USB Function is also improved with the mounting of large-capacity FIFO, programmable FIFO volume capacity settings and a strengthened continuous transfer function. Besides this, an onboard rewritable flash memory version is also available, as is the highly in demand external bus access.

USB Function USB Full-Speed (Control, Interrupt, Bulk, Isochronous)	Power Source for USB Pull-up D+ Pull-up Power Source (Supply Control)	Endpoint 9 Endpoints	FIFO 1024 Byte (MAX) ^{*1} 3.2 KByte (Total) ^{*2}	Oscillation Circuit 2 circuits	DMA Controller 4 channels	A/D Converter 10 bits x 8 channels
Serial I/O Multi-functional x 4ch	Timer Multiple 16 bits x 5	I/O Ports Input: 1 Programmable I/O: 82	Interrupt Factor 33	External Memory Connect Memory Expansion Mode Microprocessor Mode (Programmable-Wait Function)	Minimum Instruction Execution Time 62.5 ns	Package 100-pin LQFP
Supply Voltage 3.0 to 3.6V	PLL Frequency Multiplier Built-in (USB 48MHz generated internally)	CRC Calculation Circuit Selectable from 2 circuits (CRC-CCITT/CRC16)	Watchdog Timer 1 channel	Vbus Detector USB cable connection/ disconnection detector	Pull-up I/O Port 80(4-port unit)	

*1. Maximum number of bytes allowing set to just one Endpoint. Using the double buffer mode doubles transmission capability. *2. Total number of built-in FIFO.

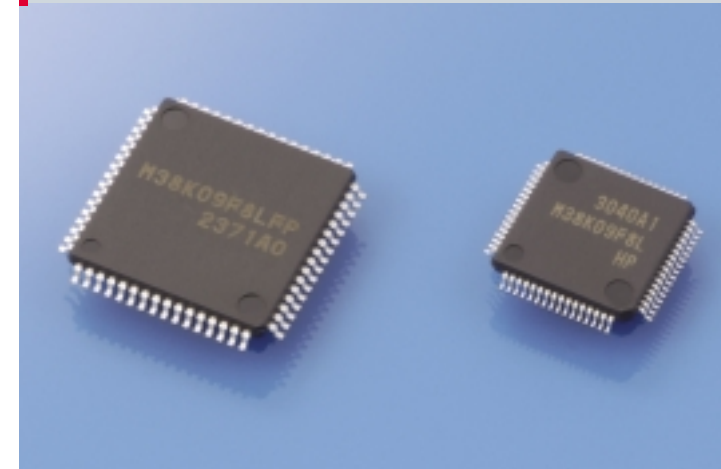
M30245 MCU Line-up										
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM (Byte)	RAM (Byte)					
M30245M8-XXXGP	100	LQFP	PTQP0100KB-A	64K	5K	16	62.5	3.0 to 3.6	-20 to 85	142/16
M30245MC-XXXGP	100	LQFP	PTQP0100KB-A	128K	10K	16	62.5	3.0 to 3.6	-20 to 85	142/16
M30245FCGP	100	LQFP	PTQP0100KB-A	128K ^{*3}	10K	16	62.5	3.0 to 3.6	-20 to 85	142/16

*3. Flash memory

Development/Evaluation Products ● **M3A-0245: M16C/24 Group M30245 Evaluation Board** → Please see P34 for details.

Full-Speed USB2.0 Function

38000 Series 38K0 Group



The 38K0 Group consists of 8-bit single-chip MCUs with built-in USB functions in compliance with Full-Speed USB2.0. The built-in 4 endpoints, external bus interface x 1, serial I/O x 1, 8-bit timer x 3 and A/D converter (8-channel) enable a variety of USB functions. In addition, 38K0 Group MCUs are suitable for USB conversion devices since the internal RAM can be accessed directly from USB and external interfaces.

USB Function USB Full-Speed (Control, Interrupt, Bulk, Isochronous)	Power Source for USB Pull-up D+ Pull-up Power Source	Endpoint 4 Endpoints	USB Buffer MAX 64 Bytes x 6 +16 Bytes (Internal RAM used) ^{*1}	Bus Interface 8 bits x 1 DMA Specification	Serial I/O UART/Clock Sync. 8 bits x 1 channel	A/D Converter 10 bits x 8 channels
Timer 8 bits x 3 (with Prescaler)	I/O Ports 48 (LED: 4)	Pull-up I/O Port 10	Interrupt Factor 15	Minimum Instruction Execution Time 250 ns	Package 64-pin LQFP (0.5mm pitch/0.8mm pitch)	Supply Voltage 3.00 to 5.25V
PLL Frequency Multiplier Built-in (USB48MHz generated internally)						

*1. Maximum number of bytes allowing set to just one Endpoint. Using the double buffer mode doubles transmission capability.

38K0 Group MCU Line-up										
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM (Byte)	RAM (Byte)					
M38K07M4L-XXXFP	64	LQFP	PLQP0064GA-A	16K	1K	12 ^{*3}	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6
M38K07M4L-XXXHP	64	LQFP	PLQP0064KB-A	16K	1K	12 ^{*3}	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6
M38K09F8LFP	64	LQFP	PLQP0064GA-A	32K ^{*2}	2K	12 ^{*3}	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6
M38K09F8LHP	64	LQFP	PLQP0064KB-A	32K ^{*2}	2K	12 ^{*3}	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6

*2. Flash memory

*3. This is the maximum oscillation frequency which can be connected to external. Use 6MHz or 8MHz internal clock at 5V, 6MHz clock at 3V.

Development/Evaluation Products ● **M3A-8K02: 38K0 Group/38K2 Group Evaluation, Development Board** → Please see P34 for details.

Full-Speed USB2.0 Function and Hub

38000 Series 38K2 Group



The 38K2 Group consists of 8-bit single-chip MCUs with built-in USB Hub + USB functions in compliance with Full-Speed USB2.0. The built-in downstream ports x 2, 6 endpoints (USB functions: 4, USB Hub: 2), external bus interface x 1, serial I/O x 1, 8-bit timer x 3 and A/D converter (8-channel) enable a variety of USB Hub + USB functions. In addition, 38K2 Group MCUs are suitable for USB conversion devices since the internal RAM can be accessed directly from USB and external interface.

USB Function USB Full-Speed (Control, Interrupt, Bulk, Isochronous)	Power Source for USB Pull-up D+ Pull-up Power Source	Endpoint 2 Endpoints (USB Hub) 4 Endpoints (USB Function)	USB Hub Function 2 downstream port	USB Buffer MAX 64 Bytes x 6 +40 Bytes (Internal RAM used)*1	Bus Interface 8 bits x 1 DMA Specification	Serial I/O UART/Clock Sync. 8 bits x 1ch
A/D Converter 10 bits x 8 channels	Timer 8 bits x 3 (with Prescaler)	I/O Ports 44 (LED: 4)	Pull-up I/O Port 10	Interrupt Factor 16	Minimum Instruction Execution Time 250ns	Package 64-pin LQFP (0.5mm pitch/0.8mm pitch)
Supply Voltage 3.00 to 5.25V	PLL Frequency Multiplier Built-in (USB 48MHz generated internally)					

*1. Maximum number of bytes allowing set to just one Endpoint. Using the double buffer mode doubles transmission capability.

38K2 Group MCU Line-up										
Part Number	Pin	Package	Package Code	Memory Size		Clock (MHz) (MAX)	Minimum Instruction Execution Time (ns)	Supply Voltage (V)	Operating Temperature (C)	Power Consumption (mW/MHz)
				ROM (Byte)	RAM (Byte)					
M38K27M4L-XXXFP	64	LQFP	PLQP0064GA-A	16K	1K	12 ⁹³	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6
M38K27M4L-XXXHP	64	LQFP	PLQP0064KB-A	16K	1K	12 ⁹³	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6
M38K29F8LFP	64	LQFP	PLQP0064GA-A	32K ⁹²	2K	12 ⁹³	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6
M38K29F8LHP	64	LQFP	PLQP0064KB-A	32K ⁹²	2K	12 ⁹³	250	3.00 to 5.25	-20 to 85	5V 125/6 3V 30/6

*2. Flash memory

*3. This is the maximum oscillation frequency which can be connected to external. Use 6MHz or 8MHz internal clock at 5V, 6MHz clock at 3V.

Development/Evaluation Products ● M3A-8K02: 38K0 Group/38K2 Group Evaluation, Development Board → Please see P34 for details.

USB2.0 Host

USB Host-IP



USB Host-IP consists of OHCI Host-IP, EHCI Host-IP and Renesas original Host-IP, which is librarized Renesas USB ASSP. It is possible to choose a number of Endpoints and FIFO capacity according to the system.

USB communication function USB Full-Speed/Low-Speed (Control, Interrupt, Bulk, Isochronous) (OHCI)	USB communication function USB Hi-Speed (Control, Interrupt, Bulk, Isochronous) (EHCI, Renesas original**)	Maximum number of connectable functions 10 Functions (Renesas original**)	Endpoint 32 Endpoints (MAX) (OHCI, EHCI) 10 pipes (Fixation) (Renesas Original)	FIFO Special memory (with modifiable size) or external memory area available (OHCI, EHCI) Special memory 16KByte (MAX) (Renesas original)
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*1. It does not support High Band Width of Isochronous and Interrupt type.

*2. Single-layer connection with an external HUB is available. When connected by the Full-Speed function via the Hi-Speed hub, the payload of 188 bytes or lower will be supported for Isochronous type.

USB2.0 Function

USB-IP



USB-IP is librarized Renesas USB ASSP and consists of Full-Speed and Hi-Speed types. It is possible to choose a number of Endpoints and FIFO capacity according to the system.

USB communication function USB Full-Speed (Control, Interrupt, Bulk, Isochronous)	USB communication function USB Hi-Speed (Control, Interrupt, Bulk, Isochronous)	Endpoint 16 Endpoints (MAX) (FS) 8 Pipes (MAX) (HS)	FIFO 4KByte (MAX) (FS) 16KByte (MAX) (HS)
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USB2.0 (480 Mbps) supporting low-capacitance surge absorption Zener diode

HZM6.2/6.8Z4MFA (MPAK-5, 4 elements), HZM6.2/6.8Z4MWA (MPAK-3, 2 elements),
RKZ6.2/6.8Z4MFAKT (VSON-5T, 4 elements),
HZD6.2/6.8Z4 (SFP, 1 element), HZL6.2/6.8Z4 (EFP, 1 element)



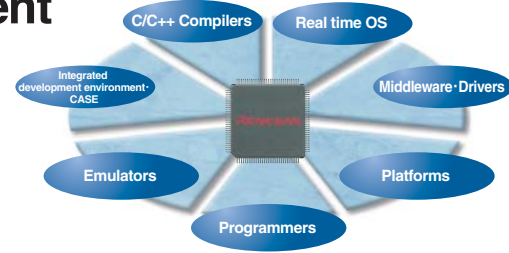
Protecting an electric equipment and an electron device from ESD surge in a high-speed signal transmission path.

Electrical characteristics*3									
Item	Code	Test condition	6.2Z4 (6.2V)			6.8Z4 (6.8V)			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Zener voltage	Vz	Iz=5mA 40ms Pulse	5.9	—	6.5	6.47	—	7.0	V
			—	—	—	—	—	2.0	μA
Reverse leak current	IR	VR=3.5V	—	—	—	—	—	—	μA
		VR=5.5V	—	—	3.0	—	—	—	μA
Junction capacitance	C	VR=0V f=1MHz	2.4	—	4.0	4.5	—	4.0	pF
			1	—	—	4.0	—	—	4.0
Dynamic resistance	Rd	Iz=5mA	—	—	60	—	—	30	Ω
ESD**	—	C=150pF R=330Ω 10 times forward and reverse impression	8	—	—	8	—	—	kV

*3 Value per one element *4 Based on IEC61000-4-2 / Judgment with reverse leak current

Renesas Development Environment

Web <http://www.renesas.com/tools>

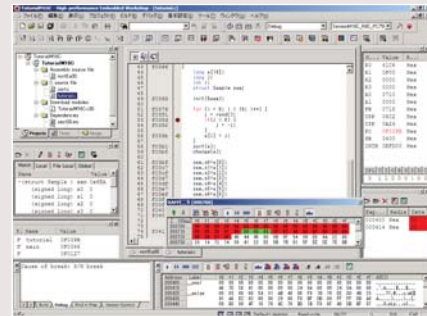


While improving the engineers' productivity by shortening development cycle, Renesas provides development tools that will allow users to get more performance out of MCUs.

Moreover, we have partnered with wide variety of vendors who can respond to Renesas customers' need and requirements as well.

High-performance Embedded Workshop

<http://www.renesas.com/hew>



- Seamless development environment
 - Each tool, from editor to debugger, is integrated and managed collectively
 - Various build*1 patterns are flexibly supported (It is possible to store multiple option specification patterns, and to add an external tool to build processes, etc.)
 - Test support function to improve debugging efficiency
 - Record and re-execution of build and debugging operations using the macro generation support function
 - Archive and compare window execution results contents from macro executions in test image files
 - Constant provision of the latest tools and documents
 - Auto update utility
 - Document updater
 - Coordination with products provided by partner vendors (such as CASE tools etc.)
- *1. Build: This is a series of processes that execute the compiling, assembling, and linkage, and then generate the object module.

Real-time OS

<http://www.renesas.com/uitron>

- High-speed and compact μ ITRON specification OS
 - Real-time OS for device-embedded systems
 - Provided along with a rich lineup of middleware and platforms to address the total solution with Renesas microprocessors.

Emulator Lineup

http://www.renesas.com/emulation_debugging

- Wide range of lineup of emulators that can be selected for your purpose
- Easily operatable from High-performance Embedded Workshop

Full-specification Emulators



E200F Emulator
The E200F emulator is a high performance emulator with on-chip debugging emulation and bus trace functions.

- Real-time emulation with a maximum operation frequency of MCU is available
- PC interface: USB

Web <http://www.renesas.com/e200f>

SH



E6000H Emulator
The E6000H emulator is a high-performance emulator complying to the maximum operation frequency of 33MHz.

- Enhanced emulation functions such as C language source level debugging, trace and break
- Realizing debugging environment complying to any operating environment
- PC Interface: PCI Bus, PC Card Bus, LAN, USB

Web <http://www.renesas.com/e6000h>

H8SX



E6000 Emulator
The E6000 emulator is a high-performance emulator complying to the maximum operation frequency of 33MHz.

- Enhanced emulation functions such as C language source level debugging, trace and break
- PC Interface: PCI Bus, PCMCIA Bus, LAN, USB

Web <http://www.renesas.com/e6000>

H8S



PC4701U Emulator
The PC4701U emulator is a high-performance emulator common to M16C, 740 family complying to the operating frequency of microcomputers up to 20MHz.

- The 4701U emulator can be modified to the debugging environment corresponding to various microcomputers at the minimum cost. (The simulation pod is changeable by each microcomputer.)
- PC Interface: LAN, USB, LPT Parallel

Web <http://www.renesas.com/pc4701u>

M16C 740

Compact Emulator



M3800T2-CPE

Fully functional, low-priced, and compact in-circuit emulator

- This product package includes a set of development tools, such as an integrated development environment, an emulator debugger, and an evaluation version of a C compiler/assembler.
- Though the emulator is small in size, it is capable of addressing full scale development through use of its capable functions, such as real-time tracing.
- PC interface: USB

Web <http://www.renesas.com/cpe>

740

On-chip Debugging Emulators



E10A-USB Emulator

The emulator is an OCD (On Chip Debugging) emulator excellent in cost performance.

- The E10A-USB emulator is capable of debugging a users system in a state as close as a final product.
- The emulator is USB bus powered and thus external power supply is not needed
- PC Interface: USB

Web http://www.renesas.com/e10a_usb

SH

H8S

H8SX

Development Tools for the SuperH™ Family

Series	Group	MCU	Software tool				Hardware tool				Programmer (Flash)
			RTOS (μ ITRON)	C/C++ Compiler Package	Simulator Debugger	IDE	Emulator *3	Emulator	Host Interface board	User system Interface board or evaluation chipboard	
SH7780	SH7722*	(H17700/4) R0R40770TRW02w*1 (H17300/PX) R0R50730PRW01w*5	C/C++ Compiler Package for SuperH Family (MISRA C Correspondence*4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H*8	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)
	SH7763*	(H17750/4) R0R40775TRW02w*1 (H17300/PX) R0R50730PRW01w*5									
SH7750	SH7760	(H17750/4) R0R40775TRW02w*1	C/C++ Compiler Package for SuperH Family (MISRA C Correspondence*4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H*8	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)
SH7700	SH7720	(H17700/4) R0R40770TRW02w*1									
SH7641	SH7641	(H17000/4) R0R40770TRW02w*1	C/C++ Compiler Package for SuperH Family (MISRA C Correspondence*4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H*8	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)
SH7200	SH7203*	(H17000/4) R0R40770TRW02w*1									
SH7260	SH7263*	(H17000/4) R0R40770TRW02w*1	C/C++ Compiler Package for SuperH Family (MISRA C Correspondence*4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H*8	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)
SH7700	SH7720	(H17700/4) R0R40770TRW02w*1									

*1. w="1": Evaluation contract for one host machine; w="5": Evaluation contract for up to five host machines; w="A": Evaluation contract for up to ten host machines; w="K": Mass production contract for up to 1,000 user systems; w="U": Mass production contract for an unlimited number of user systems; w="Z": Mass production contract for an unlimited number of user systems, with kernel source code; *2. Emulator software is bundled with an emulator. *3. HS0005KCU01H only uses the H-UDI device function. HS0005KCU02H uses the H-UDI and AUD device functions. *4. By installing the separately available MISRA C rule checker SQMint (type name: ROC00000SCW01R), the MISRA C rule inspection function is added. *5. H17300/PX supports SH-4A and SH4L-DSP MCUs. *6. The trace cable (ROE0200FOACC00) is bundled *7. A trace cable is required. When attaching multiple optional products, use only one trace cable. *8. The emulator software is being developed for SH7721. ★New product

Development Tools for the M16C Family

MCU	Group	MCU	RTOS	C Compiler Package (simulator debugger is bundled)	IDE	Emulator (emulator debugger is bundled *5)	Emulation pod	Hardware tool		Programmer
								Package name	Recommended accessories	
M16C/20	M16C/24	M30245	(M3T-MR30/4) R0R30600TRW02w*1	(M3T-NC30WA) *2 R0C30600CLW05R (MISRA C *3)	High-performance Embedded Workshop*4	PC4701U	M30245T3-RPD-E	PLQP0100K-A (100P6Q-A)	*6	*7

*1. The M3T-MR30 is the generic name for a real-time OS development kit (M3T-MR30K) and mass production contract (M3T-MR30S). *2. The M3T-NC30WA includes an integrated development environment (High-performance Embedded Workshop, TM), C compiler, assembler and simulator debugger (M16C R8C simulator debugger). *3. The MISRA C rule checker SQMint (type name: ROC00000SCW01R) is an optional product for the Renesas C compiler. *4. A high-performance Embedded Workshop is included with the C compiler package. An integrated development environment TM (bundled in the C compiler package) is also available. *5. The following and most recent version of the emulator debugger can be downloaded from the Internet (free of charge): M16C PC4701 emulator debugger *6. Refer to the accessory information website (<http://www.renesas.com/accessory>) for accessories. *7. Programs prepared by our partner vendors are addressing to your requirements.

Development Tools for the H8SX, H8S Family

Series	Group	MCU	RTOS (μ ITRON)	Software tool			Hardware tool				Programmer (Flash)						
				C/C++ Compiler Package	Simulator Debugger	IDE	Emulator *3	Emulator	Host Interface board	User system Interface board or evaluation chipboard		Options					
H8SX/1600	H8SX/1688**	(H1000/4) R0R41600TRW01w*1	C/C++ Compiler Package for H8SX, H8S, H8 Family (MISRA C Correspondence *4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H**	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)						
	H8SX/1653											(E10A-USB) HS0005KCU01H/02H	(E6000H) HS1650EPH60H*6	HS1658REC61H** (LQFP-120)	ROE00008AKCE00 (USB) or HS0008EAUF1H (USB) *7 or HS0008EASF4H (RS-232C) + ROC00000FDW04R**		
	H8SX/1668**											(E10A-USB) HS0005KCU01H/02H**	(E6000H) HS1650EPH60H*6	HS1658REC61H** (FP-144L)	ROE00008AKCE00 (USB) or HS0008EAUF1H (USB) *7 or HS0008EASF4H (RS-232C) + ROC00000FDW04R**		
	H8SX/1663											(E10A-USB) HS0005KCU01H/02H	(E6000H) HS1650EPH60H*6	HS1664ECH61H (FP-144L)	ROE00008AKCE00 (USB) or HS0008EAUF1H (USB) *7 or HS0008EASF4H (RS-232C) + ROC00000FDW04R**		
H8S/2400	H8S/2462**	(H1000/4) R0R41600TRW01w*1	C/C++ Compiler Package for H8SX, H8S, H8 Family (MISRA C Correspondence *4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H**	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)						
	H8S/2472**											—	—	—	ROE00008AKCE00 (USB) or HS0008EAUF1H (USB) *7 or HS0008EASF4H (RS-232C) + ROC00000FDW04R**		
H8S/2200	H8S/2218	(H1000/4) R0R41600TRW01w*1	C/C++ Compiler Package for H8SX, H8S, H8 Family (MISRA C Correspondence *4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H**	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)						
	H8S/2215											(E10A-USB) HS0005KCU01H/02H*8	(E6000) HS2214EPI62H*5	HS6000EIP02H (PC-Card) or HS6000EIC02H (PCI-Card) or HS6000ELN01H (LAN-Adapter) or HS6000EIU02H (USB-Adapter)	HS2218ECN61H (TFP-100G) or HS2218ECB2H (BP-112)	HS6000EMS12H (4MB) (Expansion memory)	HS0008EASF4H (RS-232C) or HS0008EAUF1H (USB) *7 + ROC00000FDW04R
	H8S/2212											(E10A-USB) HS0005KCU01H/02H*8	(E6000) HS2214EPI62H*5	HS2215REC61H (TFP-120) or HS2215RECB2H (BP-112) or HS2212ECH61H (FP-64E)	HS6000EMS12H (4MB) (Expansion memory)	HS0008EASF4H (RS-232C) or HS0008EAUF1H (USB) *7 + ROC00000FDW04R	
H8S/2100	H8S/2172	(H1000/4) R0R41600TRW01w*1	C/C++ Compiler Package for H8SX, H8S, H8 Family (MISRA C Correspondence *4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H**	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)						
H8S/2100	H8S/2172	(H1000/4) R0R41600TRW01w*1	C/C++ Compiler Package for H8SX, H8S, H8 Family (MISRA C Correspondence *4)	Simulator Debugger	IDE	(E10A-USB) HS0005KCU01H/02H**	Emulator	Host Interface board	User system Interface board or evaluation chipboard	Options	Programmer (Flash)						
												—	—	—	—	HS0008EASF4H (RS-232C) or HS0008EAUF1H (USB) *7 or HS0008EASF4H (RS-232C) + ROC00000FDW04R	

*1. w="1": Evaluation contract for one host machine; w="5": Evaluation contract for up to five host machines; w="A": Evaluation contract for up to ten host machines; w="K": Mass production contract for up to 1,000 user systems; w="U": Mass production contract, no limit on the number of user systems; w="Z": Mass production contract, no limit on the number of user systems, with kernel source code. *2. Emulator software is bundled with an emulator. *3. HS0005KCU01H only uses the H-UDI function of the device. HS0005KCU02H uses the H-UDI and AUD functions of the device. *4. The MISRA C rule checker SQMint (type name: ROC00000SCW01R) is an optional product for the Renesas C compiler. *5. A package deal with HS6000EIU02H (USB-Adapter) is also available. The package type name has -U at the end of the type name of E6000. Ex. HS2214EPI62H-U. *6. A package deal with HS6000EIU02H (USB-Adapter) is also available. The package type name has -U at the end of the type name of E6000. Ex. HS1650EPH60H-U. *7. A license of ROC00000FDW04R is bundled with HS0008EAUF1H. *8. Only the H8S/2215R, H8S/2215T corresponds. ★Under development

Development Tools for the 740 Family

Series	Group	MCU	Software tool		Hardware tool				
			Assembler Package C Compiler Package	IDE	Emulator (Compact emulator)	Emulator MCU	Package name	Recommended accessories	Programmer
38000	38K0	38K0	C compiler Package M3T-ICC740 *1 or Assembler Package M3T-SRA74 *2	High-performance Embedded Workshop *3 *4	M3800T2-CPE *5	M38K09RFS	PLOP0064KB-A (64P6Q-A) PLOP0064GA-A (64P6U-A)	*6	*7
	38K2		—	—	M38K29RFS	PLOP0064KB-A (64P6Q-A) PLOP0064GA-A (64P6U-A)	—	—	

*1. The M3T-ICC 740 product includes the IAR System's C compiler ICC740, Renesas's Integrated development environment, Renesas's simulator debugger and others. *2. The M3T-SRA74 product includes the integrated development environment, assembler, simulator debugger and others. *3. The high-performance Embedded Workshop is bundled to the C-compiler package and assembler package. *4. The integrated development environment TM (bundled to the C-compiler package and assembler package) can also be used. *5. The compact emulator M3800T2-CPE is attached with the integrated development environment, emulator debugger and compiler for evaluation purposes at no cost. *6. Refer to the accessory information website (<http://www.renesas.com/accessory>) for accessories. *7. Programs prepared by our partner vendors are addressing to your requirements.

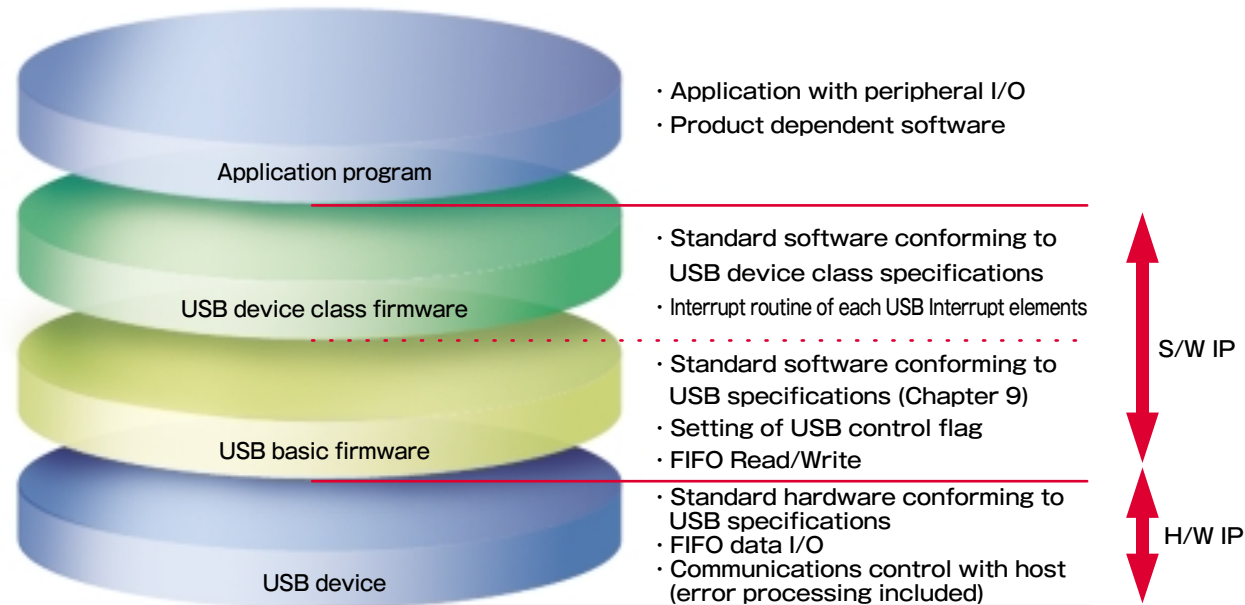
3rd Party Programmer Manufacturers

Data I/O Corporation	http://www.dataio.com E-mail: rodgerb@data-io.com	SUISEI ELECTRONICS SYSTEM CO., LTD.	http://www.suissei.co.jp/index_e.html E-mail: support@suissei.co.jp
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Minato Electronics Inc.	http://www.minato.co.jp E-mail: int-support@minato.co.jp	Wave Technology Co., Ltd.	http://www.y1000.com/ E-mail: e_sales@y1000.com
Sophia Systems Co., Ltd.	http://www.sophia-systems.com/ E-mail: sales@sophiasys.com	Yokogawa Digital Computer Corporation	http://www.yokogawa-digital.com/emb/product/NETIMPRESS.html E-mail: info-impres@yokogawa-digital.com

USB Development/Evaluation Products

Renesas supports you build demo boards for the trial USB interface control program (USB F/W) and for evaluation of the your system development. With these demo boards added to your development environment, USB protocol control is no longer necessary. The end result easier and faster system development. They also strongly support our customers' USB system development through our agreements with partner vendors.

USB program configuration (software IP)



USB Interface Control Program (USB F/W)

	Function						Host	
	Basic Firmware	Vendor	HID	Mass Storage	Comm.	Printer	Basic Firmware	Mass storage
SH7203/SH7263	○			○			○	○
SH7705				○	○	○		—
SH7727				○	○	○	○	—
SH7641				○	○	○		—
SH7720				○	○	○	○	
SH7760							○	
SH7763				*	*	*	*	
H8SX/1653			○	○	○	○		—
H8S/2212, H8S/2218			○	○	○	○		—
H8S/2215			○	○	○	○		—
H8S/2170				○				—
M30245	○							—
38K0	○				○			—
38K2	○				○			—
M66291	○	○		○	○			—
M66591	○	*			*			—
M66592	○			○	○			—
M66596	○			○			○	○
R8A66597	○			○			○	○

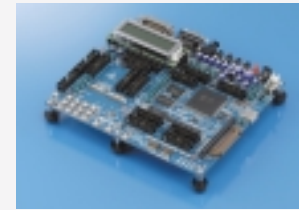
○ : Now supported/Now on Sale * : Under development —:N/A

Demo Board/Evaluation Board

Hi-Speed MCU

ROK572630D000BR <SH7263 Evaluation Board>

Equipped with hardware required to evaluate the SH7263 USB, LCDC, SSI and other functions of the SH7263. Standard embedding of USB interface, LCD module interface, audio interface, and other advantages and is suitable for advanced development of USB application products such as digital audio devices. In addition, all I/O ports of SH7263 are connected to the expansion connectors, enabling simple evaluation of peripheral functions and H/W expansion.



MS7722SE01 <SH7722 Solution Engine>

Evaluation board embedded with the H/W for evaluating the H.264/MPEG4 dynamic picture image, camera, USB, LCDC, SD Card, and other functions of SH7722. An environment where a main OS, such as μITRON or WindowsCE, can function and the on-chip debugger can connect as ready. It is also possible to use this as an easy program evaluation board in combination with a simple monitoring program. This board is a product of Hitachi ULSI Systems Co., Ltd.



Demo Board/Evaluation Board

Full-Speed MCU

MS7720RP02 <SH7720 Solution Engine Light> MS7727RP03 <SH7727 Solution Engine Light>

Evaluation board embedded with the H/W for evaluating built-in USB, LCDC, SIOF and other functions of SH7720 and SH7727. The environment where main OS such as μITRON and the on-chip debugger connection run is ready. Connection with various USB ASSP utility boards (*1) is possible through relay board M3A-ZA53. It is also possible to use it as an easy program evaluation board in combination with a simple monitor program. This board is a product of Hitachi ULSI Systems Co., Ltd.



MS7760CP02P <SH7760 Solution Engine 2>

Evaluation board embedded with the H/W for evaluating built-in USB, LCDC, SCIF and other functions of SH7760. The environment where main OS such as μITRON can work and the on-chip debugger can be used is ready. It is also possible to use it as an easy program evaluation board in combination with a simple monitor program. This board is a product of Hitachi ULSI Systems Co., Ltd.



HSB8SX1653F, HSB8SX1654F <H8SX/1653 Group Evaluation Board> HSB8SX1663F, HSB8SX1664F <H8SX/1663 Group Evaluation Board>

Evaluation board for CPUs equipped with the H8SX/1653 or 1663 Groups. Application as a program evaluation board by connecting a full emulator or an on-chip emulator. This board is a product of Hokuto Denshi Co., Ltd.



HSB8S2215RST <H8S/2215 Group Evaluation Board> HSB8S2215ST <H8S/2215 Group Evaluation Board> HSB8S2218ST <H8S/2218 Group Evaluation Board> HSB8S2212ST <H8S/2212 Group Evaluation Board>

These boards contain the H8S/2215, H8S/2218 and H8S/2212 group, and it is possible to use them as an easy program evaluation board in combination with a monitor program. Emulator connection is possible and the flash chip is loadable. In addition, the USB starter's kit is also available as an evaluation kit.



M3A-0245 <M16C/24 Group M30245 Evaluation Board>

Equipped with hardware required to evaluate USB and other peripherals functions of M30245. Loading of emulator connection or a flash-chip is possible. The board M3A-7754*1 for pitch conversion board can be connected and program rewriting of a flash-chip is easy. Moreover, since the connector which can be used to expand the universal board etc. is supported, the functional evaluation according to the use is possible. It can be used as an easy program evaluation board in combination with a simple monitor program. *1: Option



M3A-8K02 <38K0 Group/38K2 Group Evaluation, Development Board>

Evaluation/development board for the 38K0 Group and 38K2 Group. Embedded with circuits needed for USB function and USB hub, application of the external circuit use universal board (G04) facilitates simple development and evaluation of USB systems. Replacing the two-board set upper surface boards (G02, G03) makes it possible to conduct inspections with both flash-chips and debuggers. Since it is possible to exchange Vcc = 5V/3.3 V, and USB rewriting/serial rewriting of flash memory with an easy switch, changes in peripheral setup can be performed in a short time.



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